

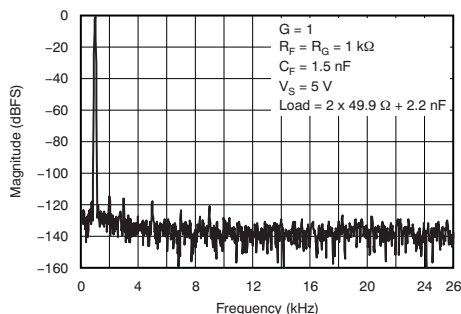
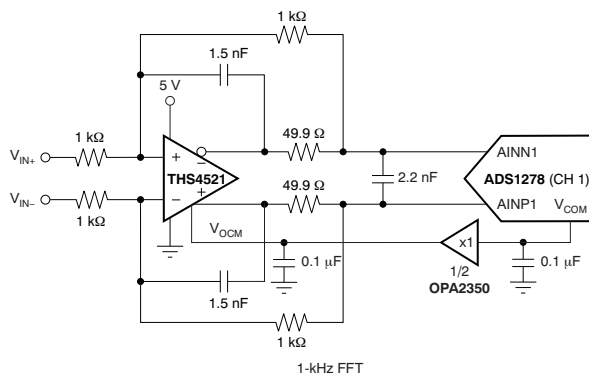


VERY LOW POWER, NEGATIVE RAIL INPUT, RAIL-TO-RAIL OUTPUT, FULLY DIFFERENTIAL AMPLIFIER

FEATURES

- Fully Differential Architecture
- Bandwidth: 145 MHz
- Slew Rate: 490 V/ μ s
- HD₂: –133 dBc at 10 kHz (1 V_{RMS}, R_L = 1 k Ω)
- HD₃: –140 dBc at 10 kHz (1 V_{RMS}, R_L = 1 k Ω)
- Input Voltage Noise: 4.6 nV/ $\sqrt{\text{Hz}}$ (f = 100 kHz)
- NRI—Negative Rail Input
- RRO—Rail-to-Rail Output
- Output Common-Mode Control (with Low Offset and Drift)
- Power Supply:
 - Voltage: +3 V (± 1.5 V) to +5.5 V (± 2.75 V)
 - Current: 1.14 mA/ch
- Power-Down Capability: 20 μ A (typ)

THS4521 and ADS1278 Combined Performance



| Tone (Hz) | Signal (dBFS) | SNR (dBc) | THD (dBc) | SINAD (dBc) | SFDR (dBc) |
|-----------|---------------|-----------|-----------|-------------|------------|
| 1 k | -0.50 | 109.1 | -107.9 | 105.5 | 113.7 |

APPLICATIONS

- Low-Power SAR and $\Delta\Sigma$ ADC Drivers
- Low-Power Differential Driver
- Low-Power Differential Signal Conditioning

DESCRIPTION

The THS4521, THS4522, and THS4524 family of devices are very low-power, fully differential op amps with rail-to-rail output and an input common-mode range that includes the negative rail. These amplifiers are designed for low-power data acquisition systems and high-density applications where power dissipation is a critical parameter.

The family includes single (THS4521), dual (THS4522), and quad (THS4524)⁽¹⁾ versions.

These fully differential op amps feature accurate output common-mode control that allows for dc-coupling when driving analog-to-digital converters (ADCs). This control, coupled with an input common-mode range below the negative rail as well as rail-to-rail output, allows for easy interfacing between single-ended, ground-referenced signal sources. Additionally, these devices are ideally suited for driving both successive-approximation register (SAR) and delta-sigma ($\Delta\Sigma$) ADCs using only a single +3V to +5V and ground power supply.

The THS4521, THS4522, and THS4524 family of fully differential op amps is characterized for operation over the full industrial temperature range from –40°C to +85°C.

RELATED PRODUCTS

| DEVICE | BW (MHz) | I _Q (mA) | THD (dBc) at 100 kHz | V _N (nV/ $\sqrt{\text{Hz}}$) | RAIL-TO-RAIL |
|---------|----------|---------------------|----------------------|--|--------------|
| THS4520 | 570 | 15.3 | –114 | 2 | Out |
| THS4121 | 100 | 16 | –79 | 5.4 | In/Out |
| THS4130 | 150 | 16 | –107 | 1.3 | No |

(1) THS4524 available 1Q 2009.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

All trademarks are the property of their respective owners.

UNLESS OTHERWISE NOTED this document contains PRODUCTION DATA information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION⁽¹⁾

| PRODUCT | PACKAGE-LEAD | PACKAGE DESIGNATOR | SPECIFIED TEMPERATURE RANGE | PACKAGE MARKING | ORDERING NUMBER | TRANSPORT MEDIA, QUANTITY |
|------------------------|--------------|--------------------|-----------------------------|-----------------|---------------------|---------------------------|
| THS4521 | SOIC-8 | D | −40°C to +85°C | TH4521 | THS4521ID | Rails, 75 |
| | | | | THS4521IDR | Tape and reel, 2500 | |
| | MSOP-8 | DGK | | 4521 | THS4521IDGKT | Tape and reel, 250 |
| | | | | | THS4521IDGKR | Tape and reel, 2500 |
| THS4522 | TSSOP-16 | PW | −40°C to +85°C | THS4522 | THS4522IPW | Rails, 90 |
| | | | | | THS4524 | Tape and reel, 2000 |
| THS4524 ⁽²⁾ | TSSOP-38 | DBT | −40°C to +85°C | THS4524 | THS4524IDBT | Rails, 50 |
| | | | | | THS4524IDBTR | Tape and reel, 2000 |

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.

(2) Available 1Q 2009.

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Over operating free-air temperature range (unless otherwise noted).

| PARAMETER | | THS4521, THS4522, THS4524 | UNIT |
|---|---------------------------|---|------|
| Supply Voltage, V_{S-} to V_{S+} | | 5.5 | V |
| Input Voltage, V_I | | $\pm V_S$ | V |
| Differential Input Voltage, V_{ID} | | 1 | V |
| Output Current, I_O | | 100 | mA |
| Continuous Power Dissipation | | See Thermal Characteristic Specifications | |
| Maximum Junction Temperature, T_J | | +150 | °C |
| Maximum Junction Temperature, T_J (continuous operation, long-term reliability) | | +125 | °C |
| Operating Free-air Temperature Range, T_A | | –40 to +85 | °C |
| Storage Temperature Range, T_{STG} | | –65 to +150 | °C |
| Lead Temperature [1,6 mm (1/16 inch) from case for 10 seconds] | | 300 | °C |
| ESD Rating: | Human Body Model (HBM) | 1300 | V |
| | Charge Device Model (CDM) | 1000 | V |
| | Machine Model (MM) | 50 | V |

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 3.3\text{ V}$

At $V_{S+} = +3.3\text{ V}$, $V_{S-} = 0\text{ V}$, $V_{OCM} = \text{open}$, $V_{OUT} = 2\text{ V}_{PP}$ (differential), $R_L = 1\text{ k}\Omega$ differential, $G = 1\text{ V/V}$, single-ended input, differential output, input and output referenced to midsupply, unless otherwise noted.

| PARAMETER | CONDITIONS | THS4521, THS4522, THS4524 | | | UNIT | TEST LEVEL ⁽¹⁾ |
|---|---|---------------------------|-------|-------|--------|---------------------------|
| | | MIN | TYP | MAX | | |
| AC PERFORMANCE | | | | | | |
| Small-Signal Bandwidth | V _{OUT} = 100 mV _{PP} , G = 1 | | 135 | | MHz | C |
| | V _{OUT} = 100 mV _{PP} , G = 2 | | 49 | | MHz | C |
| | V _{OUT} = 100 mV _{PP} , G = 5 | | 18.6 | | MHz | C |
| | V _{OUT} = 100 mV _{PP} , G = 10 | | 9.3 | | MHz | C |
| Gain Bandwidth Product | V _{OUT} = 100 mV _{PP} , G = 10 | | 93 | | MHz | C |
| Large-Signal Bandwidth | V _{OUT} = 2 V _{PP} , G = 1 | | 95 | | MHz | C |
| Bandwidth for 0.1-dB Flatness | V _{OUT} = 2 V _{PP} , G = 1 | | 20 | | MHz | C |
| Rising Slew Rate (Differential) | V _{OUT} = 2-V Step, G = 1, R _L = 200 Ω | | 420 | | V/μs | C |
| Falling Slew Rate (Differential) | V _{OUT} = 2-V Step, G = 1, R _L = 200 Ω | | 460 | | V/μs | C |
| Overshoot | V _{OUT} = 2-V Step, G = 1, R _L = 200 Ω | | 1.2 | | % | C |
| Undershoot | V _{OUT} = 2-V Step, G = 1, R _L = 200 Ω | | 2.1 | | % | C |
| Rise Time | V _{OUT} = 2-V Step, G = 1, R _L = 200 Ω | | 4 | | ns | C |
| Fall Time | V _{OUT} = 2-V Step, G = 1, R _L = 200 Ω | | 3.5 | | ns | C |
| Settling Time to 1% | V _{OUT} = 2-V Step, G = 1, R _L = 200 Ω | | 13 | | ns | C |
| Harmonic Distortion | | | | | | |
| 2nd harmonic | f = 10 kHz, V _{OUT} = 1 V _{RMS} | | −133 | | dBc | C |
| | f = 1 MHz, V _{OUT} = 2 V _{PP} | | −85 | | dBc | C |
| 3rd harmonic | f = 10 kHz, V _{OUT} = 1 V _{RMS} | | −140 | | dBc | C |
| | f = 1 MHz, V _{OUT} = 2 V _{PP} | | −90 | | dBc | C |
| Second-Order Intermodulation Distortion | Two-tone, f ₁ = 2 MHz, f ₂ = 2.2 MHz, V _{OUT} = 2-V _{PP} envelope | | −83 | | dBc | C |
| Third-Order Intermodulation Distortion | Two-tone, f ₁ = 2 MHz, f ₂ = 2.2 MHz, V _{OUT} = 2-V _{PP} envelope | | −90 | | dBc | C |
| Input Voltage Noise | f > 10 kHz | | 4.6 | | nV/√Hz | C |
| Input Current Noise | f > 100 kHz | | 0.6 | | pA/√Hz | C |
| Overdrive Recovery Time | Overdrive = ±0.5 V | | 80 | | ns | C |
| Output Balance Error | V _{OUT} = 100 mV, f ≤ 2 MHz (differential input) | | −57 | | dB | C |
| Closed-Loop Output Impedance | f = 1 MHz (differential) | | 0.3 | | Ω | C |
| CH1-CH2 Crosstalk (THS4522) | f ≤ 1 MHz, measured differentially | | −70 | | dB | C |
| Adjacent Channel Crosstalk: CH1-CH2, CH2-CH3, CH3-CH4 (THS4524) | f ≤ 1 MHz, measured differentially | | −70 | | dB | C |
| Alternate Channel Crosstalk: CH1-CH3, CH2-CH4 (THS4524) | f ≤ 1 MHz, measured differentially | | −92 | | dB | C |
| Far Channel Crosstalk: CH1-CH4 (THS4524) | f ≤ 1 MHz, measured differentially | | −95 | | dB | C |
| DC PERFORMANCE | | | | | | |
| Open-Loop Voltage Gain (A _{OL}) | | 100 | 116 | | dB | A |
| Input-Referred Offset Voltage | T _A = +25°C | | ±0.2 | ±2 | mV | A |
| | T _A = −40°C to +85°C | | ±0.5 | ±3.5 | mV | B |
| Input offset voltage drift ⁽²⁾ | T _A = −40°C to +85°C | | ±2 | | μV/°C | C |
| Input Bias Current | T _A = +25°C | | 0.65 | 0.85 | μA | B |
| | T _A = −40°C to +85°C | | 0.75 | 0.95 | μA | B |
| Input bias current drift ⁽²⁾ | T _A = −40°C to +85°C | | ±1.75 | ±2 | nA/°C | B |
| Input Offset Current | T _A = +25°C | | ±50 | ±60 | pA | B |
| | T _A = −40°C to +85°C | | ±60 | ±70 | pA | B |
| Input offset current drift ⁽²⁾ | T _A = −40°C to +85°C | | ±0.16 | ±0.25 | pA/°C | B |

(1) Test levels: **(A)** 100% tested at $+25^\circ\text{C}$. Over temperature limits set by characterization and simulation. **(B)** Limits set by characterization and simulation. **(C)** Typical value only for information.

(2) Input Offset Voltage Drift, Input Bias Current Drift, and Input Offset Current Drift are average values calculated by taking data at -40°C and $+85^\circ\text{C}$, computing the difference, and dividing by 125.

ELECTRICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 3.3\text{ V}$ (continued)

At $V_{S+} = +3.3\text{ V}$, $V_{S-} = 0\text{ V}$, $V_{OCM} = \text{open}$, $V_{OUT} = 2\text{ V}_{PP}$ (differential), $R_L = 1\text{ k}\Omega$ differential, $G = 1\text{ V/V}$, single-ended input, differential output, input and output referenced to midsupply, unless otherwise noted.

| PARAMETER | CONDITIONS | THS4521, THS4522, THS4524 | | | UNIT | TEST LEVEL ⁽¹⁾ |
|---|---|---------------------------|------------|------|-------|---------------------------|
| | | MIN | TYP | MAX | | |
| INPUT | | | | | | |
| Common-Mode Input Voltage Low | T _A = +25°C | | −0.2 | −0.1 | V | A |
| | T _A = −40°C to +85°C | | −0.1 | 0 | V | B |
| Common-Mode Input Voltage High | T _A = +25°C | 1.9 | 2 | | V | A |
| | T _A = −40°C to +85°C | 1.8 | 1.9 | | V | B |
| Common-Mode Rejection Ratio (CMRR) | | 80 | 100 | | dB | A |
| Input Resistance | | | 110 1.5 | | kΩ pF | C |
| OUTPUT | | | | | | |
| Output Voltage Low | T _A = +25°C | | 0.08 | 0.15 | V | A |
| | T _A = −40°C to +85°C | | 0.09 | 0.2 | V | B |
| Output Voltage High | T _A = +25°C | 3.0 | 3.1 | | V | A |
| | T _A = −40°C to +85°C | 2.95 | 3.05 | | V | B |
| Output Current Drive (for linear operation) | R _L = 50 Ω | | ±35 | | mA | C |
| POWER SUPPLY | | | | | | |
| Specified Operating Voltage | | 3 | | 5.5 | V | B |
| Quiescent Operating Current, per channel | T _A = +25°C | 0.9 | 1.0 | 1.2 | mA | A |
| | T _A = −40°C to +85°C | 0.85 | 1.0 | 1.25 | mA | B |
| Power-Supply Rejection Ratio (±PSRR) | | 80 | 100 | | dB | A |
| POWER DOWN | | | | | | |
| Enable Voltage Threshold | Assured on above 2.1 V | | 1.6 | 2.1 | V | A |
| Disable Voltage Threshold | Assured off below 0.7 V | 0.7 | 1.6 | | V | A |
| Disable Pin Bias Current | | | 1 | | μA | C |
| Power Down Quiescent Current | | | 10 | | μA | C |
| Turn-On Time Delay | Time to V _{OUT} = 90% of final value, V _{IN} = 2 V, R _L = 200 Ω | | 108 | | ns | B |
| Turn-Off Time Delay | Time to V _{OUT} = 10% of original value, V _{IN} = 2 V, R _L = 200 Ω | | 88 | | ns | B |
| V _{OCM} VOLTAGE CONTROL | | | | | | |
| Small-Signal Bandwidth | | | 23 | | MHz | C |
| Slew Rate | | | 55 | | V/μs | C |
| Gain | | 0.98 | 0.99 | 1.02 | V/V | A |
| Common-Mode Offset Voltage from V _{OCM} Input | Measured at V _{OUT} with V _{OCM} input driven, V _{OCM} = 1.65 V ±0.5 V | | ±2.5 | ±4 | mV | B |
| Input Bias Current | V _{OCM} = 1.65 V ±0.5 V | | ±5 | ±8 | μA | B |
| V _{OCM} Voltage Range | | 1 | 0.8 to 2.5 | 2.3 | V | A |
| Input Impedance | | | 72 1.5 | | kΩ pF | C |
| Default Output Common-Mode Voltage Offset from (V _{S+} − V _{S−})/2 | Measured at V _{OUT} with V _{OCM} input open | | ±1.5 | ±5 | mV | A |
| THERMAL CHARACTERISTICS | | | | | | |
| Specified Operating Range | | | −40 to +85 | | °C | C |
| All Packages | | | | | | |
| Thermal Resistance, θ _{JA} | Junction-to-ambient | | | | | |
| THS4521 D SO-8 | | | 194 | | °C/W | C |
| DGK MSOP-8 | | | 269 | | °C/W | C |
| THS4522 PW TSSOP-16 | | | 116 | | °C/W | C |
| THS4524 ⁽³⁾ DBT TSSOP-38 | | | 81 | | °C/W | C |

(3) THS4524 available 1Q 2009.

ELECTRICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 5\text{ V}$

At $V_{S+} = +5\text{ V}$, $V_{S-} = 0\text{ V}$, $V_{OCM} = \text{open}$, $V_{OUT} = 2\text{ V}_{PP}$ (differential), $R_F = 1\text{ k}\Omega$, $R_L = 1\text{ k}\Omega$ differential, $G = 1\text{ V/V}$, single-ended input, differential output, input and output referenced to midsupply, unless otherwise noted.

| PARAMETER | CONDITIONS | THS4521, THS4522, THS4524 | | | UNIT | TEST LEVEL ⁽¹⁾ |
|---|---|---------------------------|-------|-------|--------|---------------------------|
| | | MIN | TYP | MAX | | |
| AC PERFORMANCE | | | | | | |
| Small-Signal Bandwidth | V _{OUT} = 100 mV _{PP} , G = 1 | | 145 | | MHz | C |
| | V _{OUT} = 100 mV _{PP} , G = 2 | | 50 | | MHz | C |
| | V _{OUT} = 100 mV _{PP} , G = 5 | | 20 | | MHz | C |
| | V _{OUT} = 100 mV _{PP} , G = 10 | | 9.5 | | MHz | C |
| Gain Bandwidth Product | V _{OUT} = 100 mV _{PP} , G = 10 | | 95 | | MHz | C |
| Large-Signal Bandwidth | V _{OUT} = 2 V _{PP} , G = 1 | | 145 | | MHz | C |
| Bandwidth for 0.1-dB Flatness | V _{OUT} = 2 V _{PP} , G = 1 | | 30 | | MHz | C |
| Rising Slew Rate (Differential) | V _{OUT} = 2-V Step, G = 1, R _L = 200 Ω | | 490 | | V/μs | C |
| Falling Slew Rate (Differential) | V _{OUT} = 2-V Step, G = 1, R _L = 200 Ω | | 600 | | V/μs | C |
| Overshoot | V _{OUT} = 2-V Step, G = 1, R _L = 200 Ω | | 1 | | % | C |
| Undershoot | V _{OUT} = 2-V Step, G = 1, R _L = 200 Ω | | 2.6 | | % | C |
| Rise Time | V _{OUT} = 2-V Step, G = 1, R _L = 200 Ω | | 3.4 | | ns | C |
| Fall Time | V _{OUT} = 2-V Step, G = 1, R _L = 200 Ω | | 3 | | ns | C |
| Settling Time to 1% | V _{OUT} = 2-V Step, G = 1, R _L = 200 Ω | | 10 | | ns | C |
| Harmonic Distortion | | | | | | |
| 2nd harmonic | f = 10 kHz, V _{OUT} = 1 V _{RMS} | | −133 | | dBc | C |
| | f = 1 MHz, V _{OUT} = 2 V _{PP} | | −85 | | dBc | C |
| 3rd harmonic | f = 10 kHz, V _{OUT} = 1 V _{RMS} | | −140 | | dBc | C |
| | f = 1 MHz, V _{OUT} = 2 V _{PP} | | −91 | | dBc | C |
| Second-Order Intermodulation Distortion | Two-tone, f ₁ = 2 MHz, f ₂ = 2.2 MHz, V _{OUT} = 2-V _{PP} envelope | | −86 | | dBc | C |
| Third-Order Intermodulation Distortion | Two-tone, f ₁ = 2 MHz, f ₂ = 2.2 MHz, V _{OUT} = 2-V _{PP} envelope | | −93 | | dBc | C |
| Input Voltage Noise | f > 10 kHz | | 4.6 | | nV/√Hz | C |
| Input Current Noise | f > 100 kHz | | 0.6 | | pA/√Hz | C |
| Overdrive Recovery Time | Overdrive = ±0.5 V | | 75 | | ns | C |
| Output Balance Error | V _{OUT} = 100 mV, f < 2 MHz, V _{IN} differential | | −57 | | dB | C |
| Closed-Loop Output Impedance | f = 1 MHz (differential) | | 0.3 | | Ω | C |
| CH1-CH2 Crosstalk (THS4522) | f ≤ 1 MHz, measured differentially | | −70 | | dB | C |
| Adjacent Channel Crosstalk: CH1-CH2, CH2-CH3, CH3-CH4 (THS4524) | f ≤ 1 MHz, measured differentially | | −70 | | dB | C |
| Alternate Channel Crosstalk: CH1-CH3, CH2-CH4 (THS4524) | f ≤ 1 MHz, measured differentially | | −92 | | dB | C |
| Far Channel Crosstalk: CH1-CH4 (THS4524) | f ≤ 1 MHz, measured differentially | | −95 | | dB | C |
| DC PERFORMANCE | | | | | | |
| Open-Loop Voltage Gain (A _{OL}) | | 100 | 119 | | dB | A |
| Input-Referred Offset Voltage | T _A = +25°C | | ±0.24 | ±2 | mV | A |
| | T _A = −40°C to +85°C | | ±0.5 | ±3.5 | mV | B |
| Input offset voltage drift ⁽²⁾ | T _A = −40°C to +85°C | | ±2 | | μV/°C | B |
| Input Bias Current | T _A = +25°C | | 0.7 | 0.9 | μA | B |
| | T _A = −40°C to +85°C | | 0.9 | 1.1 | μA | B |
| Input bias current drift ⁽²⁾ | T _A = −40°C to +85°C | | ±1.8 | ±2.2 | nA/°C | B |
| Input Offset Current | T _A = +25°C | | ±50 | ±60 | pA | B |
| | T _A = −40°C to +85°C | | ±60 | ±75 | pA | B |
| Input offset current drift ⁽²⁾ | T _A = −40°C to +85°C | | ±0.16 | ±0.25 | pA/°C | B |

(1) Test levels: **(A)** 100% tested at $+25^\circ\text{C}$. Over temperature limits set by characterization and simulation. **(B)** Limits set by characterization and simulation. **(C)** Typical value only for information.

(2) Input Offset Voltage Drift, Input Bias Current Drift, and Input Offset Current Drift are average values calculated by taking data at -40°C and $+85^\circ\text{C}$, computing the difference, and dividing by 125.

ELECTRICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 5\text{ V}$ (continued)

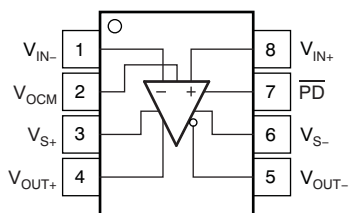
At $V_{S+} = +5\text{ V}$, $V_{S-} = 0\text{ V}$, $V_{OCM} = \text{open}$, $V_{OUT} = 2\text{ V}_{PP}$ (differential), $R_F = 1\text{ k}\Omega$, $R_L = 1\text{ k}\Omega$ differential, $G = 1\text{ V/V}$, single-ended input, differential output, input and output referenced to midsupply, unless otherwise noted.

| PARAMETER | CONDITIONS | THS4521, THS4522, THS4524 | | | UNIT | TEST LEVEL ⁽¹⁾ |
|---|---|------------------------------|------------|------|--------|---------------------------|
| | | MIN | TYP | MAX | | |
| INPUT | | | | | | |
| Common-Mode Input Voltage Low | T _A = +25°C | | −0.2 | −0.1 | V | A |
| | T _A = −40°C to +85°C | | −0.1 | 0 | V | B |
| Common-Mode Input Voltage High | T _A = +25°C | 3.6 | 3.7 | | V | A |
| | T _A = −40°C to +85°C | 3.5 | 3.6 | | V | B |
| Common-Mode Rejection Ratio (CMRR) | | 80 | 102 | | dB | A |
| Input Impedance | | | 100 0.7 | | kΩ pF | C |
| OUTPUT | | | | | | |
| Output Voltage Low | T _A = +25°C | | 0.10 | 0.15 | V | A |
| | T _A = −40°C to +85°C | | 0.115 | 0.2 | V | B |
| Output Voltage High | T _A = +25°C | 4.7 | 4.75 | | V | A |
| | T _A = −40°C to +85°C | 4.65 | 4.7 | | V | B |
| Output Current Drive (for linear operation) | R _L = 50 Ω | | ±55 | | mA | C |
| POWER SUPPLY | | | | | | |
| Specified Operating Voltage | | 3 | | 5.5 | V | B |
| Quiescent Operating Current, per channel | T _A = +25°C | 0.95 | 1.14 | 1.25 | mA | A |
| | T _A = −40°C to +85°C | 0.9 | 1.15 | 1.3 | mA | B |
| Power-Supply Rejection Ratio (±PSRR) | | 80 | 100 | | dB | A |
| POWER DOWN | | | | | | |
| Enable Voltage Threshold | Ensured <i>on</i> above 2.1 V | 0.7 | 1.6 | 2.1 | V | A |
| Disable Voltage Threshold | Ensured <i>off</i> below 0.7 V | | 1.6 | | V | A |
| Disable Pin Bias Current | | | 1 | | μA | C |
| Power Down Quiescent Current | | | 20 | | μA | C |
| Turn-On Time Delay | Time to V _{OUT} = 90% of final value, V _{IN} = 2 V, R _L = 200 Ω | | 70 | | ns | B |
| Turn-Off Time Delay | Time to V _{OUT} = 10% of original value, V _{IN} = 2 V, R _L = 200 Ω | | 60 | | ns | B |
| V _{OCM} VOLTAGE CONTROL | | | | | | |
| Small-Signal Bandwidth | Measured at V _{OUT} with V _{OCM} input driven, V _{OCM} = 2.5V ±1 V | 0.98 | 23 | | MHz | C |
| Slew Rate | | | 55 | | V/μs | C |
| Gain | | | 0.99 | 1.02 | V/V | A |
| Common-Mode Offset Voltage from V _{OCM} Input | | | ±5 | ±9 | mV | B |
| Input Bias Current | | V _{OCM} = 2.5V ±1 V | | ±20 | ±25 | μA |
| V _{OCM} Voltage Range | | 1 | 0.8 to 4.2 | 4 | V | A |
| Input Impedance | | | 46 1.5 | | kΩ pF | C |
| Default Output Common-Mode Voltage Offset from (V _{S+} − V _{S−})/2 | Measured at V _{OUT} with V _{OCM} input open | | ±1 | ±5 | mV | A |
| THERMAL CHARACTERISTICS | | | | | | |
| Specified Operating Range All Packages | Junction-to-ambient | −40 | | +85 | °C | C |
| Thermal Resistance, θ _{JA} | | | | | | |
| THS4521 D SO-8 | | | 194 | | °C/W | C |
| DGK MSOP-8 | | | 269 | | °C/W | C |
| THS4522 PW TSSOP-16 | | | 116 | | °C/W | C |
| THS4524 ⁽³⁾ DBT TSSOP-38 | | | 81 | | °C/W | C |

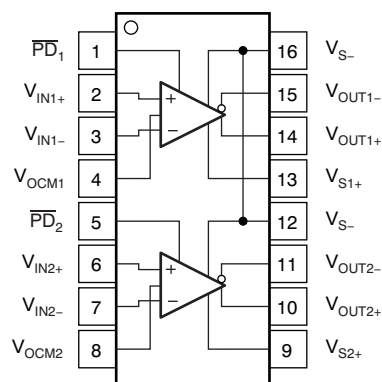
(3) THS4524 available 1Q 2009.

DEVICE INFORMATION

THS4521
SOIC-8, MSOP-8 (D, DGK PACKAGES)
(TOP VIEW)



THS4522
TSSOP-16 (PW PACKAGE)
(TOP VIEW)



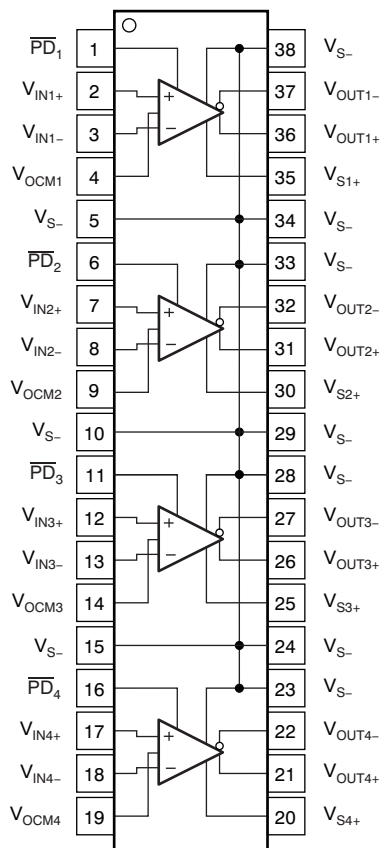
TERMINAL FUNCTIONS: THS4521

| SOIC-8, MSOP-8 | | DESCRIPTION |
|----------------|------------------------|---|
| PIN NO. | NAME | |
| 1 | V _{IN-} | Inverting amplifier input |
| 2 | V _{OCM} | Common-mode voltage input |
| 3 | V _{S+} | Amplifier positive power-supply input |
| 4 | V _{OUT+} | Noninverting amplifier output |
| 5 | V _{OUT-} | Inverting amplifier output |
| 6 | V _{S-} | Amplifier negative power-supply input. Note that V _{S-} is tied together on multi-channel devices. |
| 7 | $\overline{\text{PD}}$ | Power down. $\overline{\text{PD}}$ = logic low puts device into low-power mode. $\overline{\text{PD}}$ = logic high or open for normal operation. |
| 8 | V _{IN+} | Noninverting amplifier input |

TERMINAL FUNCTIONS: THS4522

| TSSOP-16 | | DESCRIPTION |
|----------|--------------------------|---|
| PIN NO. | NAME | |
| 1 | $\overline{\text{PD}}_1$ | Power down 1. $\overline{\text{PD}}$ = logic low puts device into low-power mode. $\overline{\text{PD}}$ = logic high or open for normal operation. |
| 2 | V _{IN1+} | Noninverting amplifier 1 input |
| 3 | V _{IN1-} | Inverting amplifier 1 input |
| 4 | V _{OCM1} | Common-mode voltage input 1 |
| 5 | $\overline{\text{PD}}_2$ | Power down 2. $\overline{\text{PD}}$ = logic low puts device into low-power mode. $\overline{\text{PD}}$ = logic high or open for normal operation. |
| 6 | V _{IN2+} | Noninverting amplifier 2 input |
| 7 | V _{IN2-} | Inverting amplifier 2 input |
| 8 | V _{OCM2} | Common-mode voltage input 2 |
| 9 | V _{S+2} | Amplifier 2 positive power-supply input |
| 10 | V _{OUT2+} | Noninverting amplifier 2 output |
| 11 | V _{OUT2-} | Inverting amplifier 2 output |
| 12 | V _{S-} | Negative power-supply input. Note that V _{S-} is tied together on multi-channel devices. |
| 13 | V _{S+1} | Amplifier 1 positive power-supply input |
| 14 | V _{OUT1+} | Noninverting amplifier 1 output |
| 15 | V _{OUT1-} | Inverting amplifier 1 output |
| 16 | V _{S-} | Negative power-supply input. Note that V _{S-} is tied together on multi-channel devices. |

THS4524⁽¹⁾
TSSOP-38 (DBT PACKAGE)
(TOP VIEW)



(1) Available 1Q 2009.

TERMINAL FUNCTIONS: THS4524

| TSSOP-38 | | DESCRIPTION |
|----------|--------------------------|--|
| PIN NO. | NAME | |
| 1 | $\overline{\text{PD}}_1$ | Power down 1. $\overline{\text{PD}}$ = logic low puts channel into low-power mode. $\overline{\text{PD}}$ = logic high or open for normal operation. |
| 2 | $V_{\text{IN}1+}$ | Noninverting amplifier 1 input |
| 3 | $V_{\text{IN}1-}$ | Inverting amplifier 1 input |
| 4 | $V_{\text{OCM}1}$ | Common-mode voltage input 1 |
| 5 | $V_{\text{S}-}$ | Negative power-supply input. Note that $V_{\text{S}-}$ is tied together on multi-channel devices. |
| 6 | $\overline{\text{PD}}_2$ | Power down 2. $\overline{\text{PD}}$ = logic low puts channel into low-power mode. $\overline{\text{PD}}$ = logic high or open for normal operation. |
| 7 | $V_{\text{IN}2+}$ | Noninverting amplifier 2 input |
| 8 | $V_{\text{IN}2-}$ | Inverting amplifier 2 input |
| 9 | $V_{\text{OCM}2}$ | Common-mode voltage input 2 |
| 10 | $V_{\text{S}-}$ | Negative power-supply input. Note that $V_{\text{S}-}$ is tied together on multi-channel devices. |
| 11 | $\overline{\text{PD}}_3$ | Power down 3. $\overline{\text{PD}}$ = logic low puts channel into low-power mode. $\overline{\text{PD}}$ = logic high or open for normal operation. |
| 12 | $V_{\text{IN}3+}$ | Noninverting amplifier 3 input |
| 13 | $V_{\text{IN}3-}$ | Inverting amplifier 3 input |
| 14 | $V_{\text{OCM}3}$ | Common-mode voltage input 3 |
| 15 | $V_{\text{S}-}$ | Negative power-supply input. Note that $V_{\text{S}-}$ is tied together on multi-channel devices. |
| 16 | $\overline{\text{PD}}_4$ | Power down 4. $\overline{\text{PD}}$ = logic low puts channel into low-power mode. $\overline{\text{PD}}$ = logic high or open for normal operation. |
| 17 | $V_{\text{IN}4+}$ | Noninverting amplifier 4 input |
| 18 | $V_{\text{IN}4-}$ | Inverting amplifier 4 input |
| 19 | $V_{\text{OCM}4}$ | Common-mode voltage input 4 |
| 20 | $V_{\text{S}4+}$ | Amplifier 4 positive power-supply input |
| 21 | $V_{\text{OUT}4+}$ | Noninverting amplifier 4 output |
| 22 | $V_{\text{OUT}4-}$ | Inverting amplifier 4 output |
| 23 | $V_{\text{S}-}$ | Negative power-supply input. Note that $V_{\text{S}-}$ is tied together on multi-channel devices. |
| 24 | $V_{\text{S}-}$ | Negative power-supply input. Note that $V_{\text{S}-}$ is tied together on multi-channel devices. |
| 25 | $V_{\text{S}3+}$ | Amplifier 3 positive power-supply input |
| 26 | $V_{\text{OUT}3+}$ | Noninverting amplifier3 output |
| 27 | $V_{\text{OUT}3-}$ | Inverting amplifier3 output |
| 28 | $V_{\text{S}-}$ | Negative power-supply input. Note that $V_{\text{S}-}$ is tied together on multi-channel devices. |
| 29 | $V_{\text{S}-}$ | Negative power-supply input. Note that $V_{\text{S}-}$ is tied together on multi-channel devices. |
| 30 | $V_{\text{S}2+}$ | Amplifier 2 positive power-supply input |
| 31 | $V_{\text{OUT}2+}$ | Noninverting amplifier 2 output |
| 32 | $V_{\text{OUT}2-}$ | Inverting amplifier 2 output |
| 33 | $V_{\text{S}-}$ | Negative power-supply input. Note that $V_{\text{S}-}$ is tied together on multi-channel devices. |
| 34 | $V_{\text{S}-}$ | Negative power-supply input. Note that $V_{\text{S}-}$ is tied together on multi-channel devices. |
| 35 | $V_{\text{S}1+}$ | Amplifier 1 positive power-supply input |
| 36 | $V_{\text{OUT}1+}$ | Noninverting amplifier 1 output |
| 37 | $V_{\text{OUT}1-}$ | Inverting amplifier 1 output |
| 38 | $V_{\text{S}-}$ | Negative power-supply input. Note that $V_{\text{S}-}$ is tied together on multi-channel devices. |

TYPICAL CHARACTERISTICS

Table of Graphs: $V_{S+} - V_{S-} = 3.3\text{ V}$

| TITLE | FIGURE |
|---|---------------------------|
| Small-Signal Frequency Response | Figure 1 |
| Large-Signal Frequency Response | Figure 2 |
| Large- and Small-Signal Pulse Response | Figure 3 |
| Slew Rate vs V_{OUT} Step | Figure 4 |
| Overdrive Recovery | Figure 5 |
| 10-kHz Output Spectrum on AP Analyzer | Figure 6 |
| Harmonic Distortion vs Frequency | Figure 7 |
| Harmonic Distortion vs Output Voltage at 1 MHz | Figure 8 |
| Harmonic Distortion vs Gain at 1 MHz | Figure 9 |
| Harmonic Distortion vs Load at 1 MHz | Figure 10 |
| Harmonic Distortion vs V_{OCM} at 1 MHz | Figure 11 |
| Two-Tone, Second- and Third-Order Intermodulation Distortion vs Frequency | Figure 12 |
| Single-Ended Output Voltage Swing vs Load Resistance | Figure 13 |
| Main Amplifier Differential Output Impedance vs Frequency | Figure 14 |
| Frequency Response vs C_{LOAD} ($R_{LOAD} = 1\text{ k}\Omega$) | Figure 15 |
| R_O vs C_{LOAD} ($R_{LOAD} = 1\text{ k}\Omega$) | Figure 16 |
| Rejection Ratio vs Frequency | Figure 17 |
| THS4522, THS4524 Crosstalk (Measured Differentially) | Figure 18 |
| Turn-on Time | Figure 19 |
| Turn-off Time | Figure 20 |
| Input-Referred Voltage Noise and Current Noise Spectral Density | Figure 21 |
| Main Amplifier Differential Open-Loop Gain and Phase | Figure 22 |
| Output Balance Error vs Frequency | Figure 23 |
| V_{OCM} Small-Signal Frequency Response | Figure 24 |
| V_{OCM} Large-Signal Frequency Response | Figure 25 |
| V_{OCM} Input Impedance vs Frequency | Figure 26 |

Table of Graphs: $V_{S+} - V_{S-} = 5\text{ V}$

| TITLE | FIGURE |
|---|---------------------------|
| Small-Signal Frequency Response | Figure 27 |
| Large-Signal Frequency Response | Figure 28 |
| Large- and Small-Signal Pulse Response | Figure 29 |
| Slew Rate vs V_{OUT} Step | Figure 30 |
| Overdrive Recovery | Figure 31 |
| 10-kHz Output Spectrum on AP Analyzer | Figure 32 |
| Harmonic Distortion vs Frequency | Figure 33 |
| Harmonic Distortion vs Output Voltage at 1 MHz | Figure 34 |
| Harmonic Distortion vs Gain at 1 MHz | Figure 35 |
| Harmonic Distortion vs Load at 1 MHz | Figure 36 |
| Harmonic Distortion vs V_{OCM} at 1 MHz | Figure 37 |
| Two-Tone, Second- and Third-Order Intermodulation Distortion vs Frequency | Figure 38 |
| Single-Ended Output Voltage Swing vs Load Resistance | Figure 39 |
| Main Amplifier Differential Output Impedance vs Frequency | Figure 40 |
| Frequency Response vs C_{LOAD} ($R_{LOAD} = 1\text{ k}\Omega$) | Figure 41 |
| R_O vs C_{LOAD} ($R_{LOAD} = 1\text{ k}\Omega$) | Figure 42 |
| Rejection Ratio vs Frequency | Figure 43 |
| THS4522, THS4524 Crosstalk (Measured Differentially) | Figure 44 |
| Turn-on Time | Figure 45 |
| Turn-off Time | Figure 46 |
| Input-Referred Voltage Noise and Current Noise Spectral Density | Figure 47 |
| Main Amplifier Differential Open-Loop Gain and Phase | Figure 48 |
| Output Balance Error vs Frequency | Figure 49 |
| V_{OCM} Small-Signal Frequency Response | Figure 50 |
| V_{OCM} Large-Signal Frequency Response | Figure 51 |
| V_{OCM} Input Impedance vs Frequency | Figure 52 |

TYPICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 3.3\text{ V}$

At $V_{S+} = +3.3\text{ V}$, $V_{S-} = 0\text{ V}$, $V_{OCM} = \text{open}$, $V_{OUT} = 2\text{ V}_{PP}$ (differential), $R_L = 1\text{ k}\Omega$ differential, $G = 1\text{ V/V}$, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

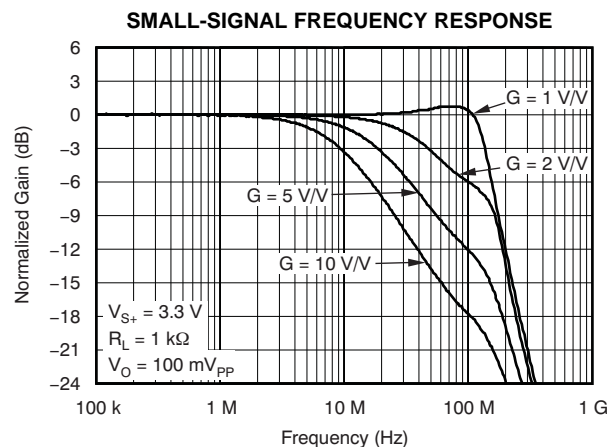


Figure 1.

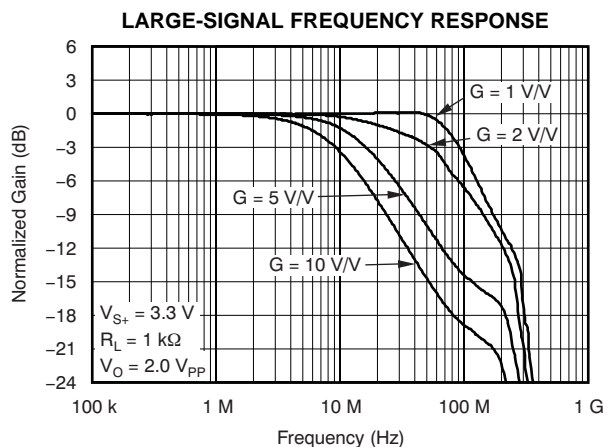


Figure 2.

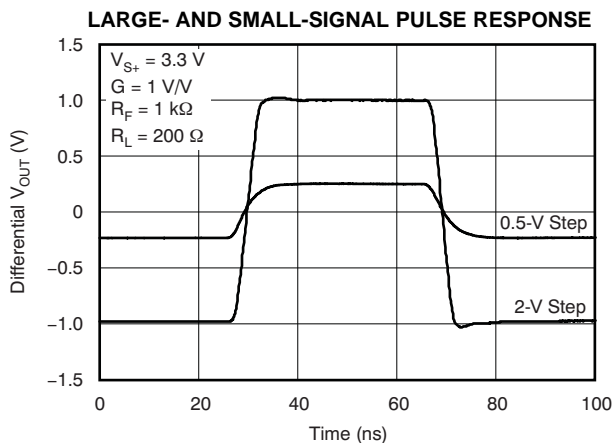


Figure 3.

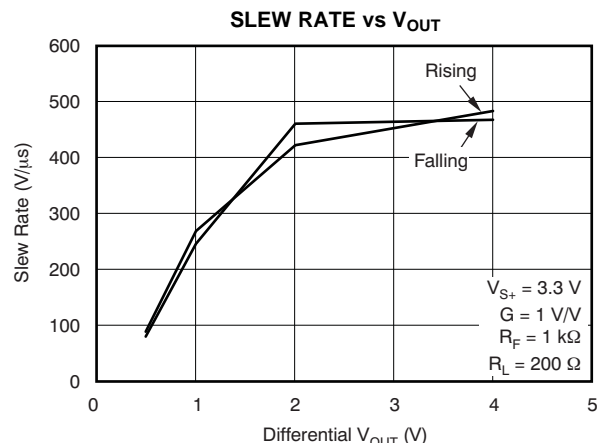


Figure 4.

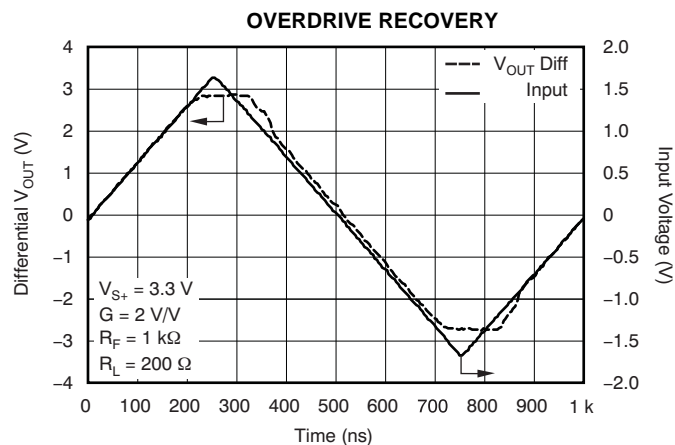


Figure 5.

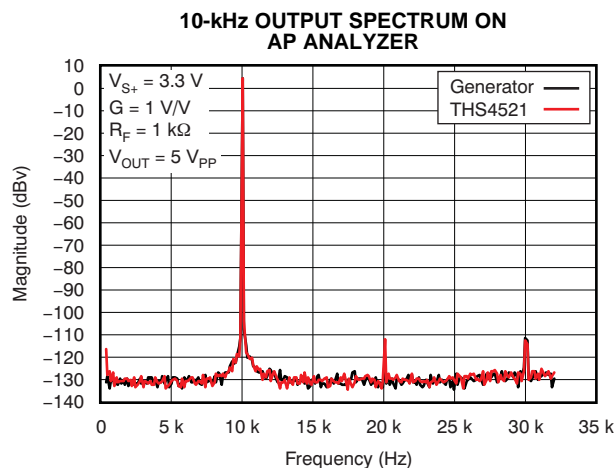


Figure 6.

TYPICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 3.3\text{ V}$ (continued)

At $V_{S+} = +3.3\text{ V}$, $V_{S-} = 0\text{ V}$, $V_{OCM} = \text{open}$, $V_{OUT} = 2\text{ V}_{PP}$ (differential), $R_L = 1\text{ k}\Omega$ differential, $G = 1\text{ V/V}$, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

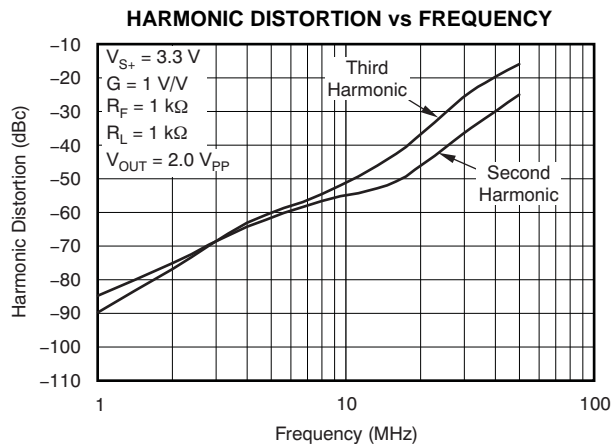


Figure 7.

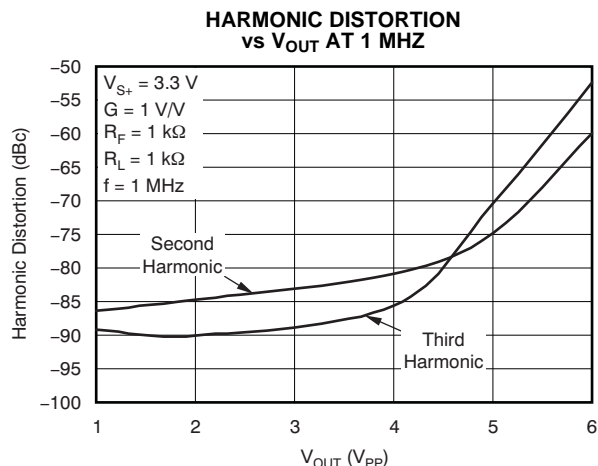


Figure 8.

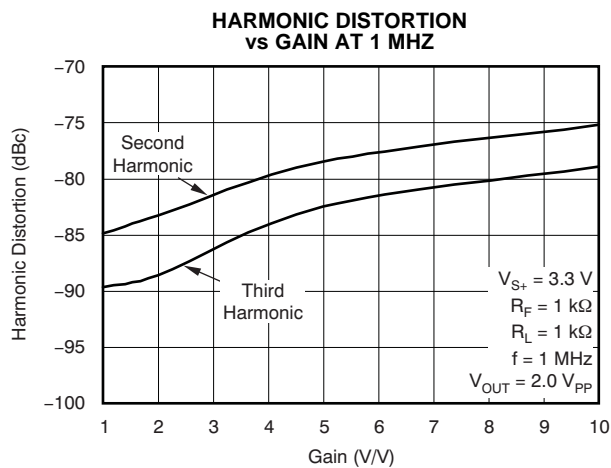


Figure 9.

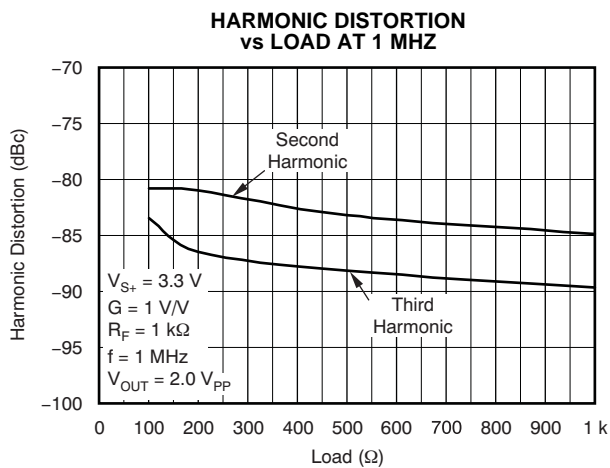


Figure 10.

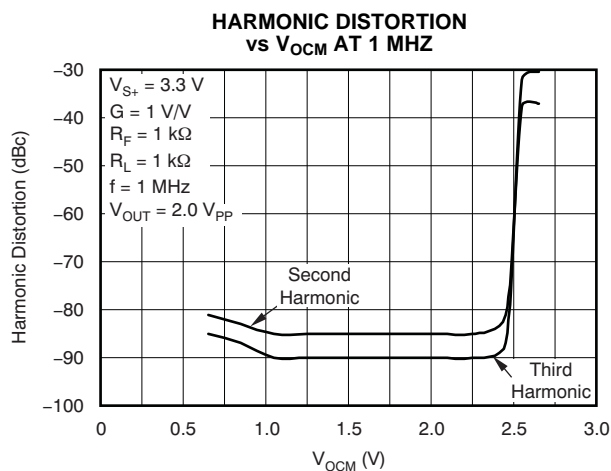


Figure 11.

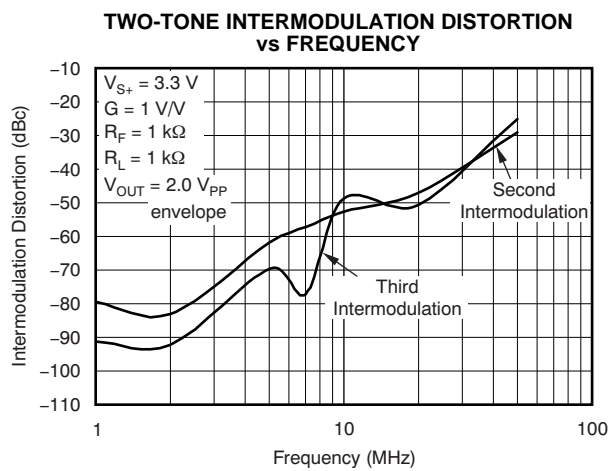


Figure 12.

TYPICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 3.3\text{ V}$ (continued)

At $V_{S+} = +3.3\text{ V}$, $V_{S-} = 0\text{ V}$, $V_{OCM} = \text{open}$, $V_{OUT} = 2\text{ V}_{PP}$ (differential), $R_L = 1\text{ k}\Omega$ differential, $G = 1\text{ V/V}$, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

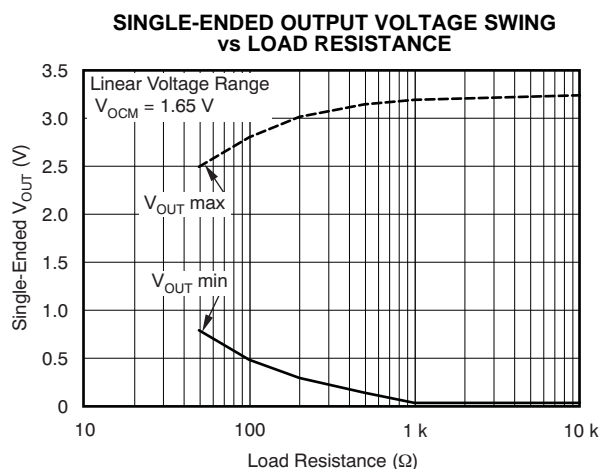


Figure 13.

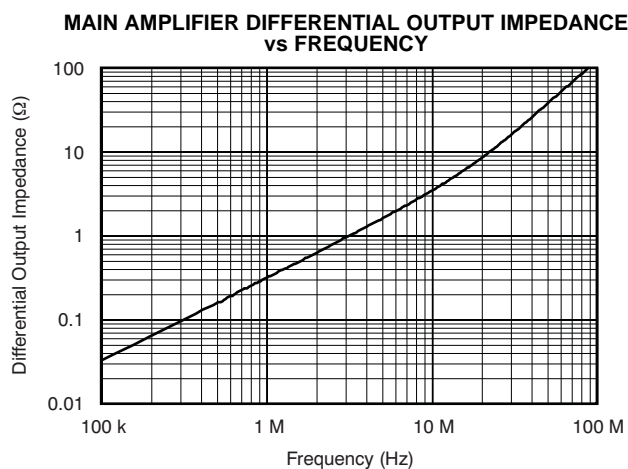


Figure 14.

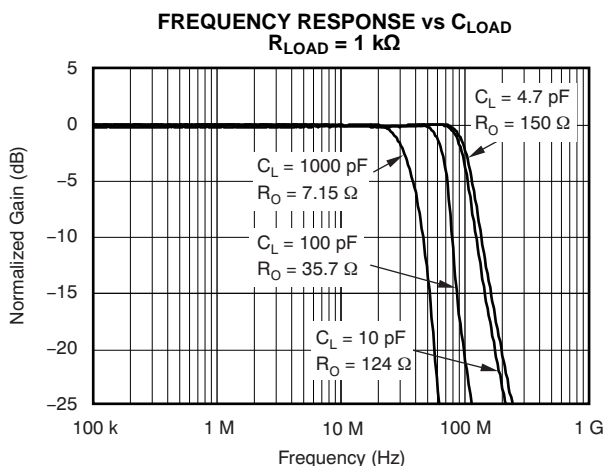


Figure 15.

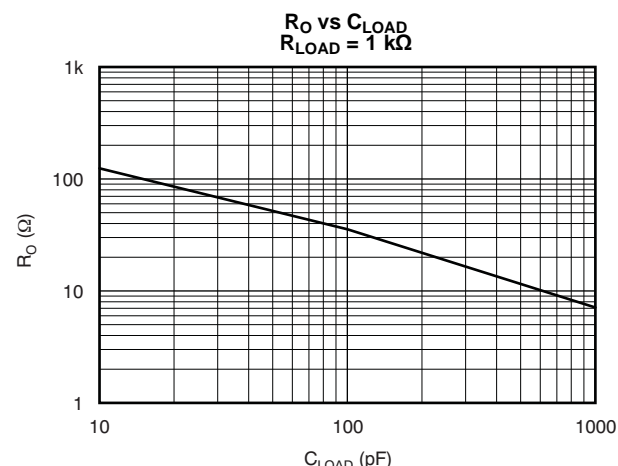


Figure 16.

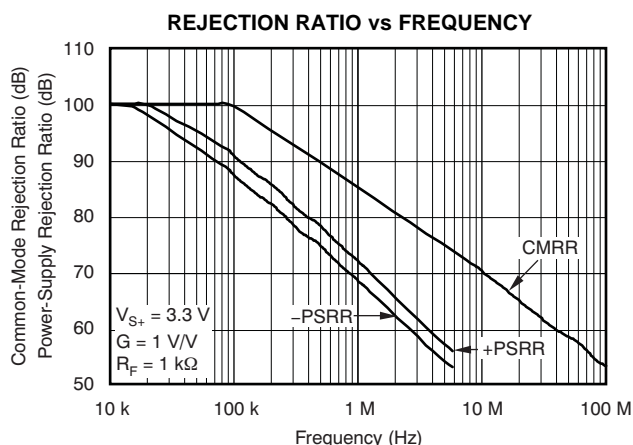


Figure 17.

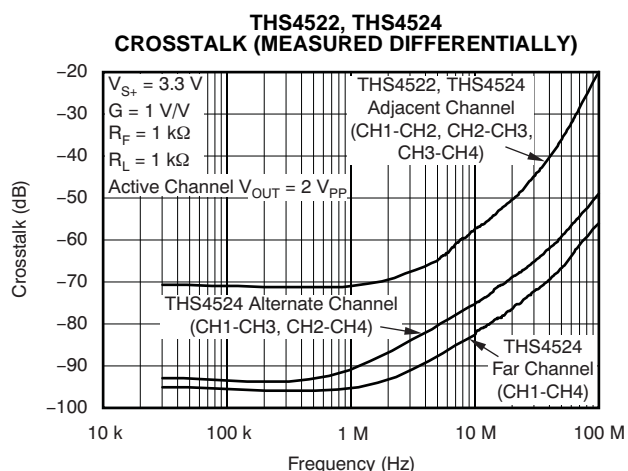


Figure 18.

TYPICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 3.3\text{ V}$ (continued)

At $V_{S+} = +3.3\text{ V}$, $V_{S-} = 0\text{ V}$, $V_{OCM} = \text{open}$, $V_{OUT} = 2\text{ V}_{PP}$ (differential), $R_L = 1\text{ k}\Omega$ differential, $G = 1\text{ V/V}$, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

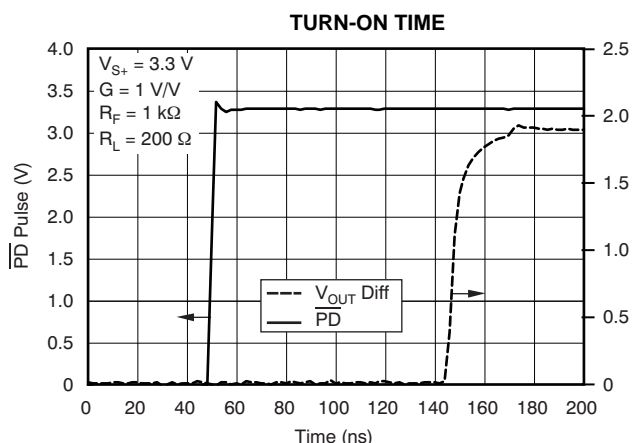


Figure 19.

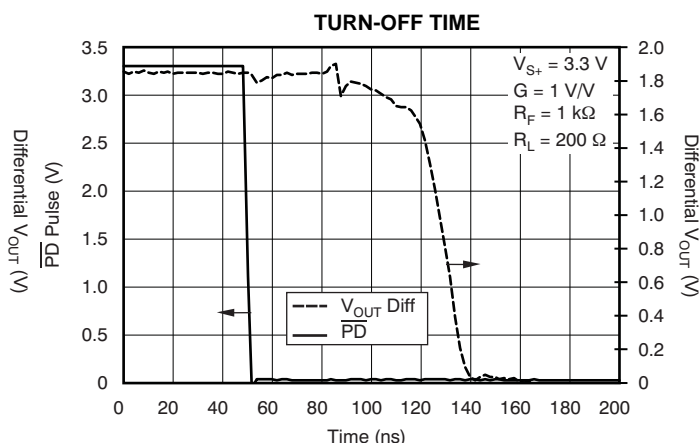


Figure 20.

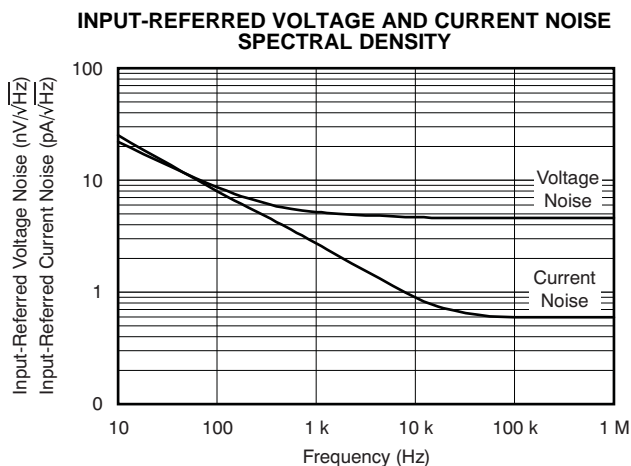


Figure 21.

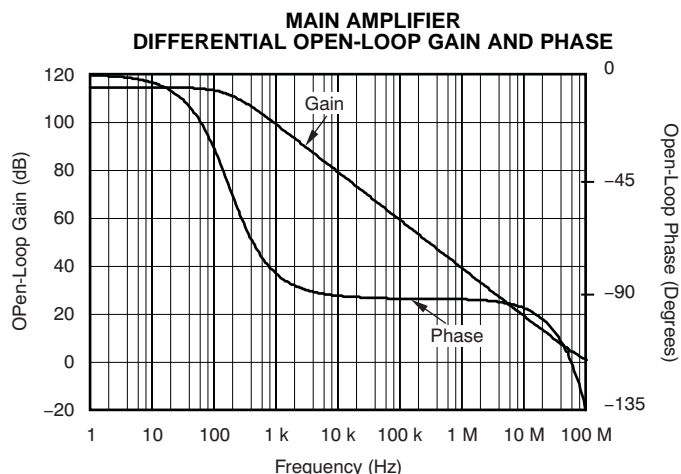


Figure 22.

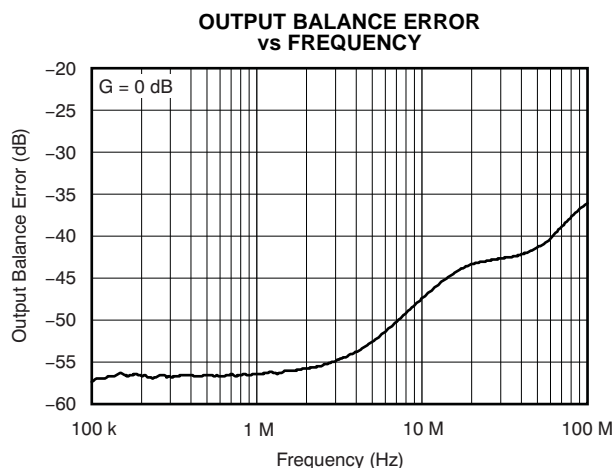


Figure 23.

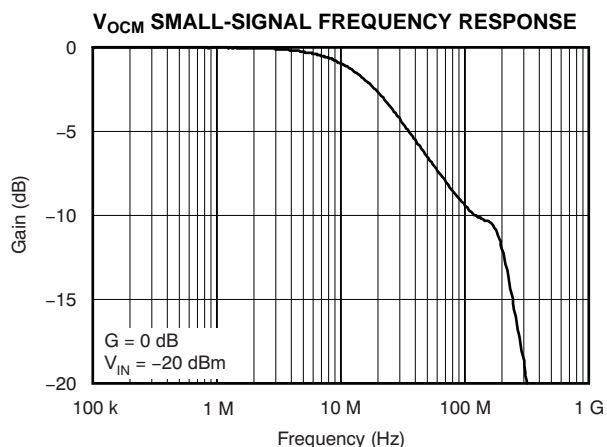


Figure 24.

TYPICAL CHARACTERISTICS: $V_{S+} - V_{S-} = 3.3\text{ V}$ (continued)

At $V_{S+} = +3.3\text{ V}$, $V_{S-} = 0\text{ V}$, $V_{OCM} = \text{open}$, $V_{OUT} = 2\text{ V}_{PP}$ (differential), $R_L = 1\text{ k}\Omega$ differential, $G = 1\text{ V/V}$, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

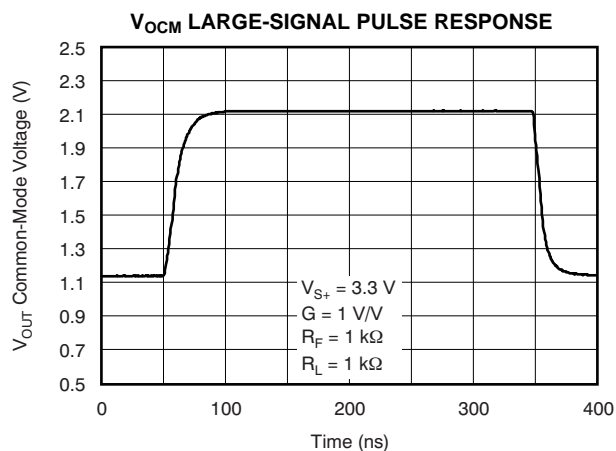


Figure 25.

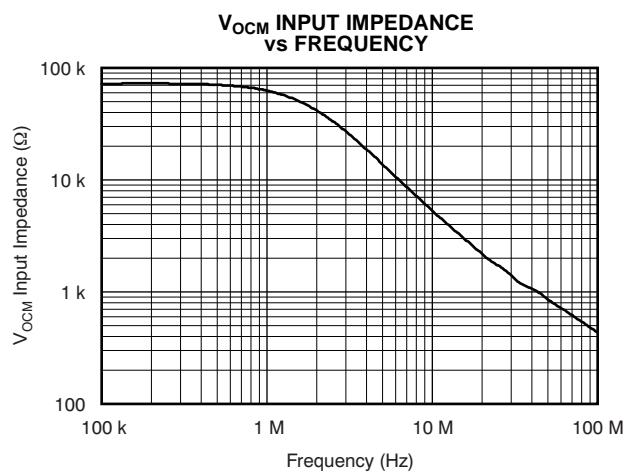


Figure 26.

TYPICAL CHARACTERISTICS: 5 V

At $V_{S+} = +5\text{ V}$, $V_{S-} = 0\text{ V}$, $V_{OCM} = \text{open}$, $V_{OUT} = 2\text{ V}_{PP}$ (differential), $R_F = 1\text{ k}\Omega$, $R_L = 1\text{ k}\Omega$ differential, $G = 1\text{ V/V}$, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

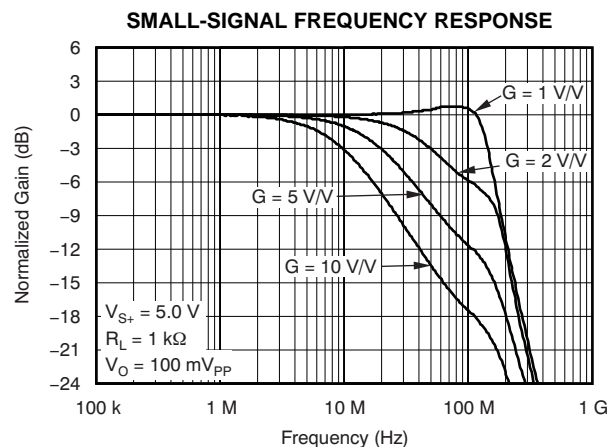


Figure 27.

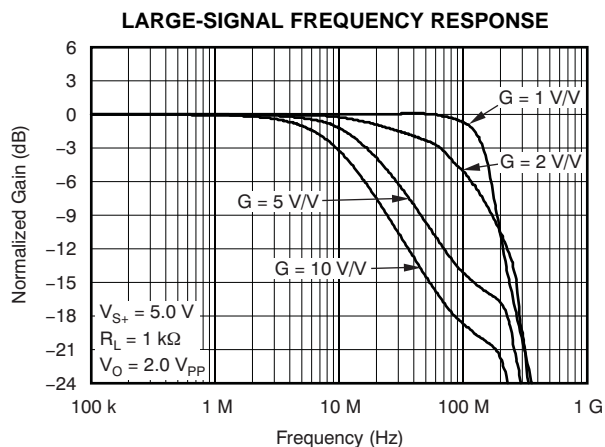


Figure 28.

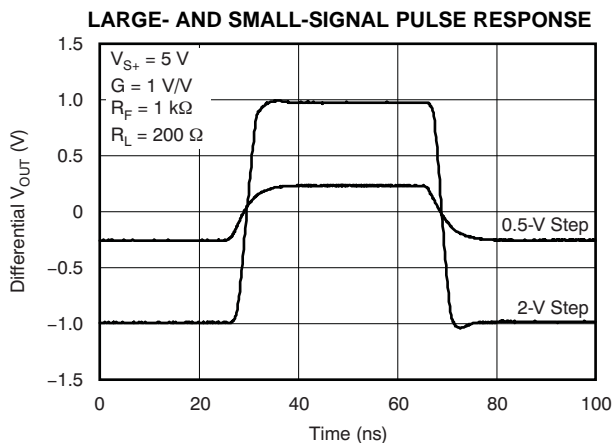


Figure 29.

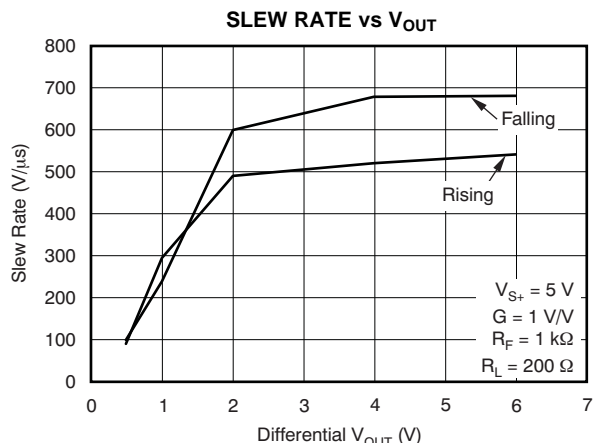


Figure 30.

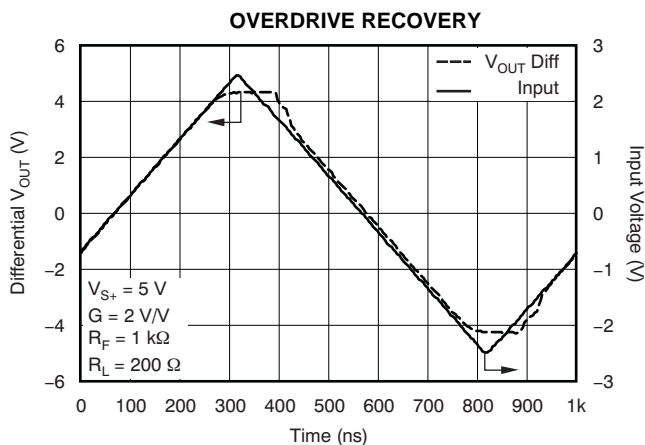


Figure 31.

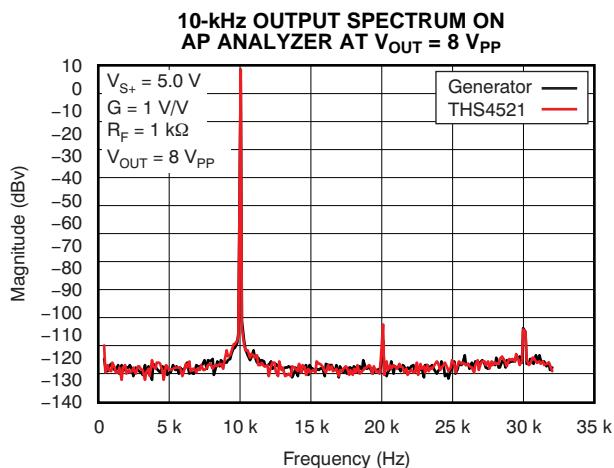


Figure 32.

TYPICAL CHARACTERISTICS: 5 V (continued)

At $V_{S+} = +5\text{ V}$, $V_{S-} = 0\text{ V}$, $V_{OCM} = \text{open}$, $V_{OUT} = 2\text{ V}_{PP}$ (differential), $R_F = 1\text{ k}\Omega$, $R_L = 1\text{ k}\Omega$ differential, $G = 1\text{ V/V}$, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

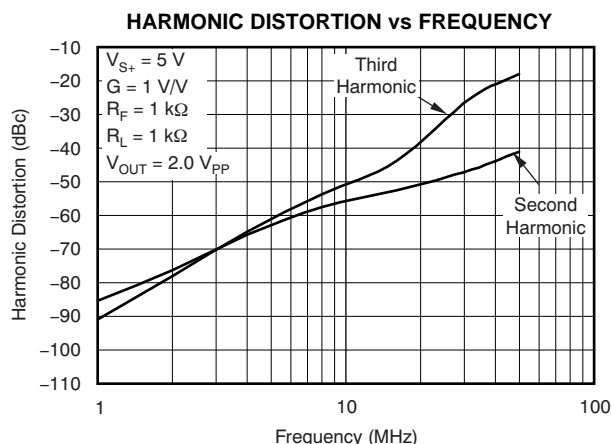


Figure 33.

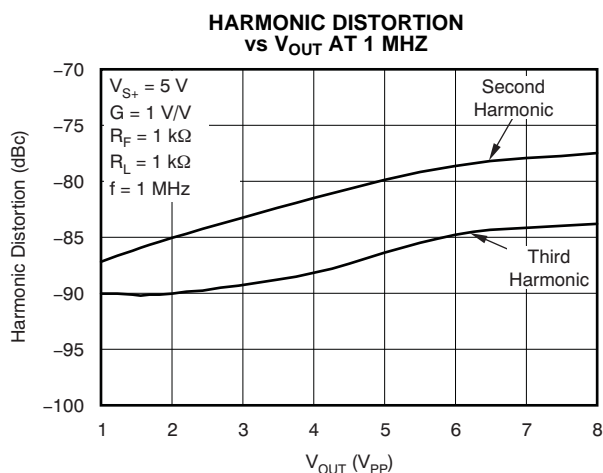


Figure 34.

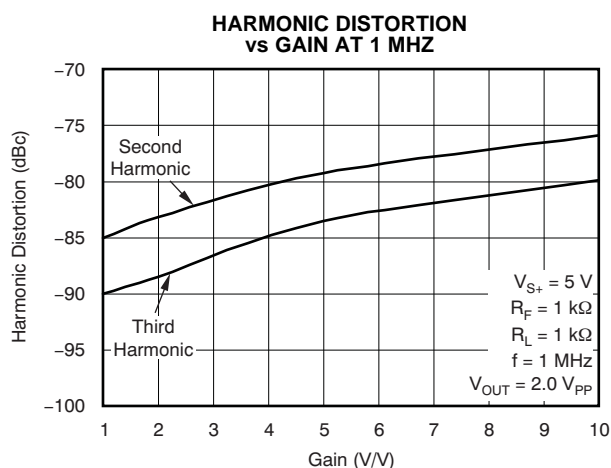


Figure 35.

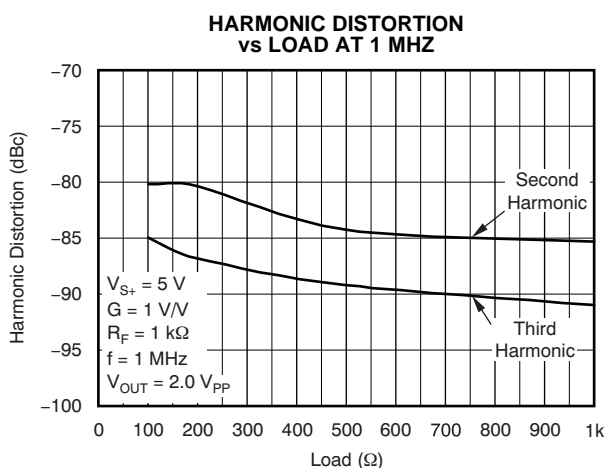


Figure 36.

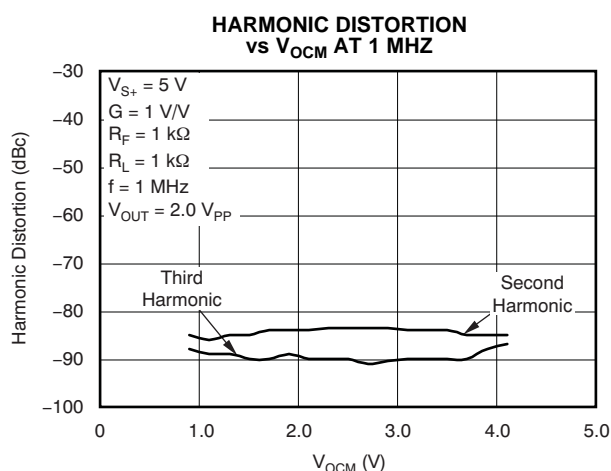


Figure 37.

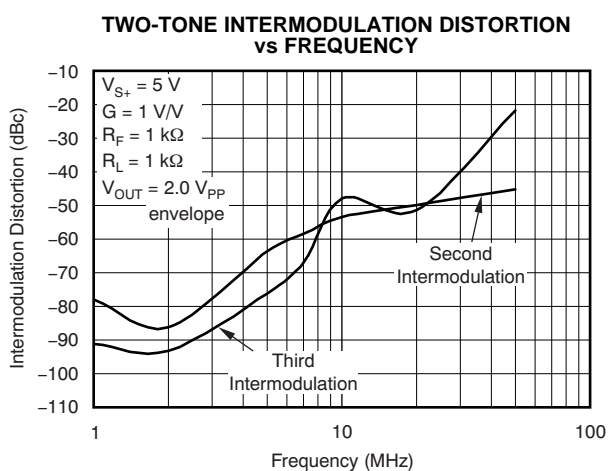


Figure 38.

TYPICAL CHARACTERISTICS: 5 V (continued)

At $V_{S+} = +5\text{ V}$, $V_{S-} = 0\text{ V}$, $V_{OCM} = \text{open}$, $V_{OUT} = 2\text{ V}_{PP}$ (differential), $R_F = 1\text{ k}\Omega$, $R_L = 1\text{ k}\Omega$ differential, $G = 1\text{ V/V}$, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

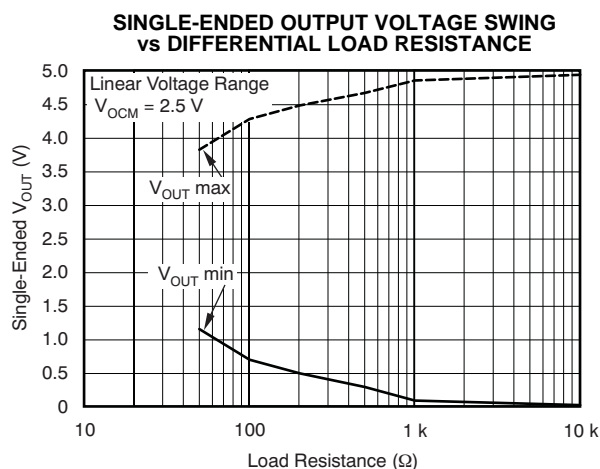


Figure 39.

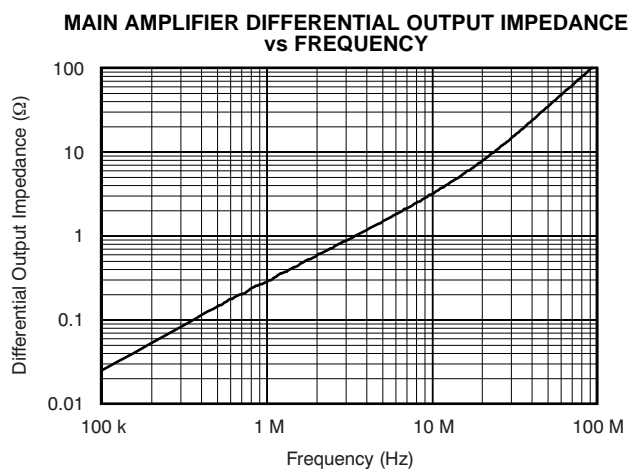


Figure 40.

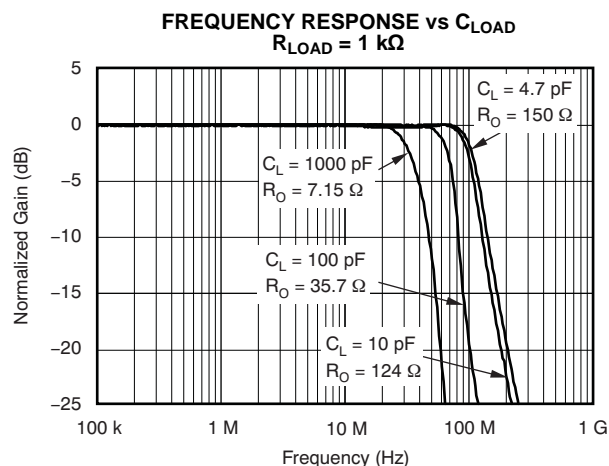


Figure 41.

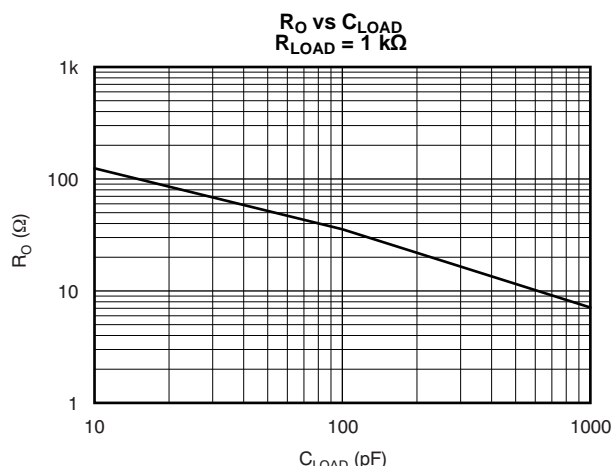


Figure 42.

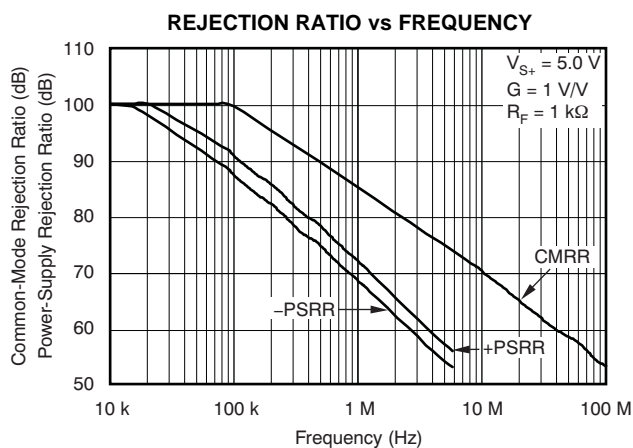


Figure 43.

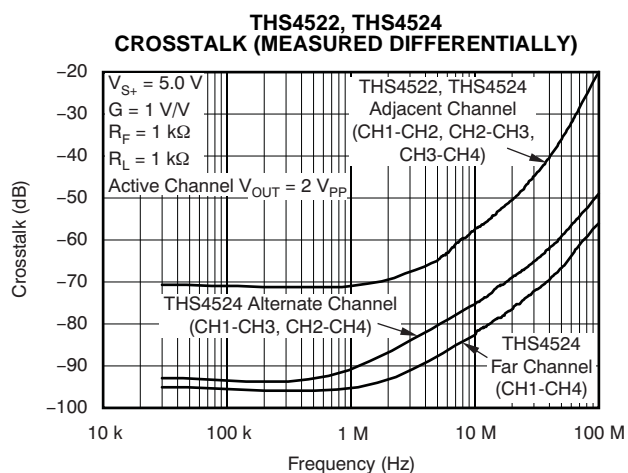


Figure 44.

TYPICAL CHARACTERISTICS: 5 V (continued)

At $V_{S+} = +5\text{ V}$, $V_{S-} = 0\text{ V}$, $V_{OCM} = \text{open}$, $V_{OUT} = 2\text{ V}_{PP}$ (differential), $R_F = 1\text{ k}\Omega$, $R_L = 1\text{ k}\Omega$ differential, $G = 1\text{ V/V}$, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

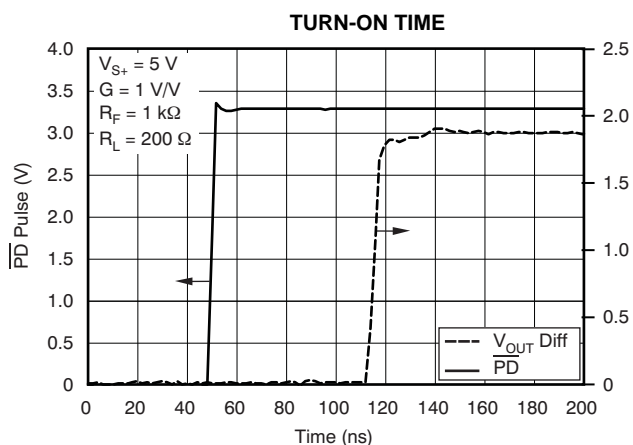


Figure 45.

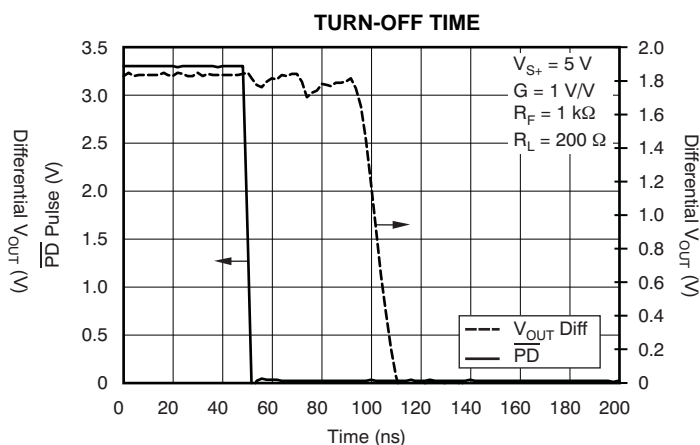


Figure 46.

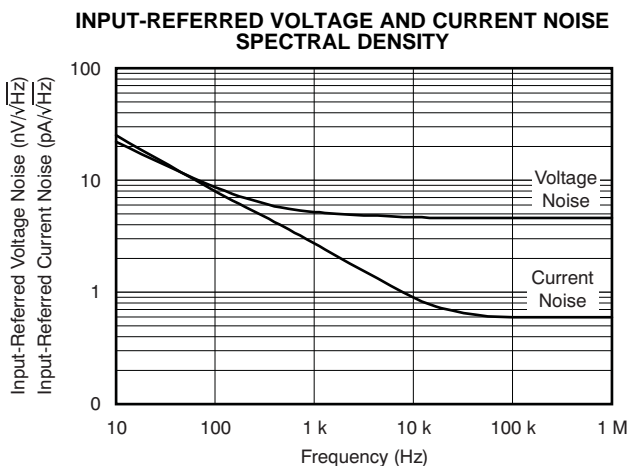


Figure 47.

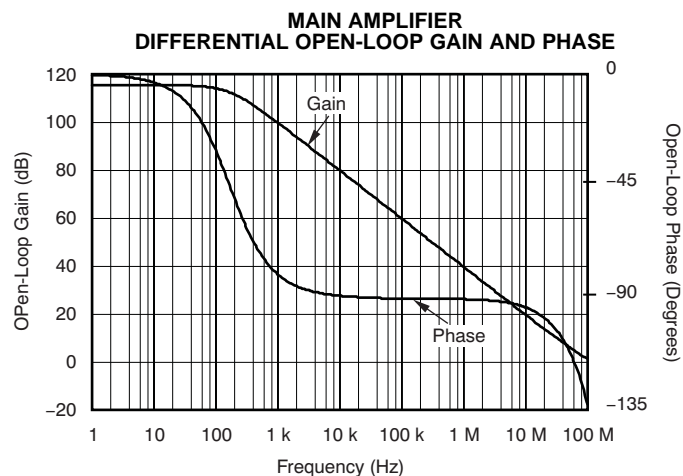


Figure 48.

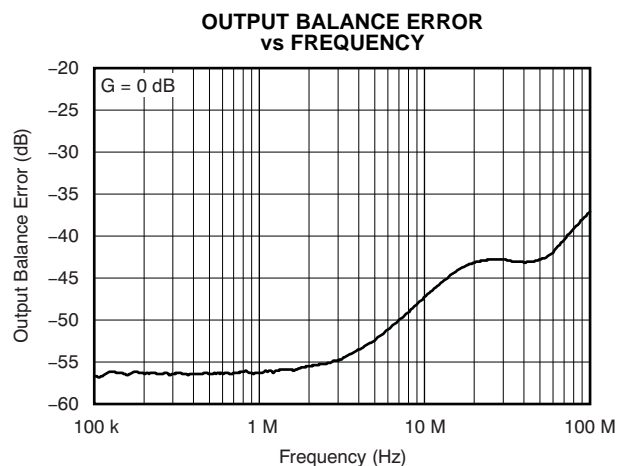


Figure 49.

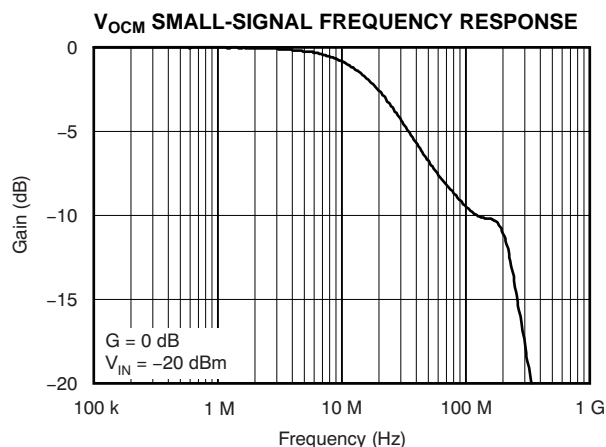


Figure 50.

TYPICAL CHARACTERISTICS: 5 V (continued)

At $V_{S+} = +5\text{ V}$, $V_{S-} = 0\text{ V}$, $V_{OCM} = \text{open}$, $V_{OUT} = 2\text{ V}_{PP}$ (differential), $R_F = 1\text{ k}\Omega$, $R_L = 1\text{ k}\Omega$ differential, $G = 1\text{ V/V}$, single-ended input, differential output, and input and output referenced to midsupply, unless otherwise noted.

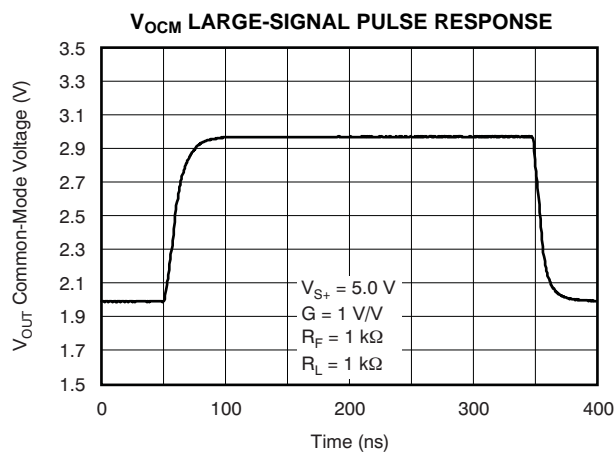


Figure 51.

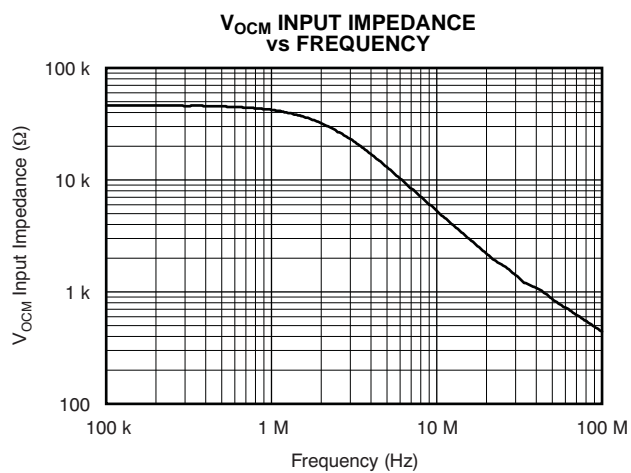


Figure 52.

TEST CIRCUITS

Overview

The THS4521, THS4522, and THS4524 family is tested with the test circuits shown in this section; all circuits are built using the available THS4521 evaluation module (EVM). For simplicity, power-supply decoupling is not shown; see the layout in the [Applications](#) section for recommendations. Depending on the test conditions, component values change in accordance with [Table 1](#) and [Table 2](#), or as otherwise noted. In some cases the signal generators used are ac-coupled and in others they dc-coupled 50-Ω sources. To balance the amplifier when ac-coupled, a 0.22-μF capacitor and 49.9-Ω resistor to ground are inserted across R_{IT} on the alternate input; when dc-coupled, only the 49.9-Ω resistor to ground is added across R_{IT} . A split power supply is used to ease the interface to common test equipment, but the amplifier can be operated in a single-supply configuration as described in the [Applications](#) section with no impact on performance. Also, for most of the tests, except as noted, the devices are tested with single-ended inputs and a transformer on the output to convert the differential output to single-ended because common lab test equipment has single-ended inputs and outputs. Similar or better performance can be expected with differential inputs and outputs.

As a result of the voltage divider on the output formed by the load component values, the amplifier output is attenuated. The **Atten** column in [Table 2](#) shows the attenuation expected from the resistor divider. When using a transformer at the output (as shown in [Figure 54](#)), the signal sees slightly more loss because of transformer and line loss; these numbers are approximate.

Table 1. Gain Component Values for Single-Ended Input⁽¹⁾

| Gain | R_F | R_G | R_{IT} |
|--------|-------|--------|----------|
| 1 V/V | 1 kΩ | 1 kΩ | 52.3 Ω |
| 2 V/V | 1 kΩ | 487 Ω | 53.6 Ω |
| 5 V/V | 1 kΩ | 187 Ω | 59.0 Ω |
| 10 V/V | 1 kΩ | 86.6 Ω | 69.8 Ω |

1. Gain setting includes 50-Ω source impedance. Components are chosen to achieve gain and 50-Ω input termination.

Table 2. Load Component Values For 1:1 Differential to Single-Ended Output Transformer⁽¹⁾

| R_L | R_O | R_{OT} | Atten |
|-------|--------|----------|---------|
| 100 Ω | 24.9 Ω | Open | 6 dB |
| 200 Ω | 86.6 Ω | 69.8 Ω | 16.8 dB |
| 499 Ω | 237 Ω | 56.2 Ω | 25.5 dB |
| 1 kΩ | 487 Ω | 52.3 Ω | 31.8 dB |

1. Total load includes 50-Ω termination by the test equipment. Components are chosen to achieve load and 50-Ω line termination through a 1:1 transformer.

Frequency Response

The circuit shown in [Figure 53](#) is used to measure the frequency response of the circuit.

An HP network analyzer is used as the signal source and the measurement device. The output impedance of the HP network analyzer is dc-coupled and is 50 Ω. R_{IT} and R_G are chosen to impedance-match to 50 Ω and maintain the proper gain. To balance the amplifier, a 49.9-Ω resistor to ground is inserted across R_{IT} on the alternate input.

The output is probed using a Tektronix high-impedance differential probe across the 953-Ω resistor and referred to the amplifier output by adding back the 0.42-dB because of the voltage divider on the output.

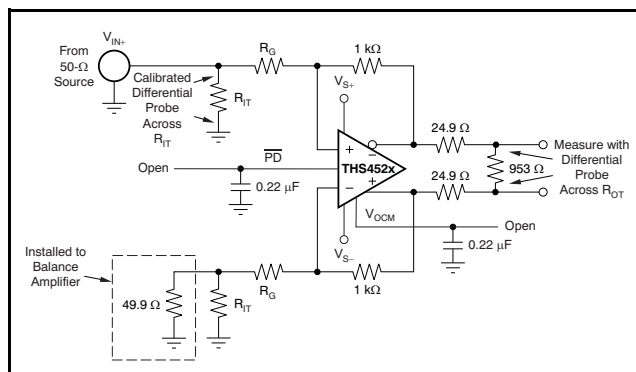


Figure 53. Frequency Response Test Circuit

Distortion

The circuit shown in [Figure 54](#) is used to measure harmonic and intermodulation distortion of the amplifier.

An HP signal generator is used as the signal source and the output is measured with a Rhode and Schwarz spectrum analyzer. The output impedance of the HP signal generator is ac-coupled and is 50 Ω . R_{IT} and R_G are chosen to impedance match to 50 Ω and maintain the proper gain. To balance the amplifier, a 0.22- μ F capacitor and 49.9- Ω resistor to ground are inserted across R_{IT} on the alternate input.

A low-pass filter is inserted in series with the input to reduce harmonics generated at the signal source. The level of the fundamental is measured and then a high-pass filter is inserted at the output to reduce the fundamental so it does not generate distortion in the input of the spectrum analyzer.

The transformer used in the output to convert the signal from differential to single-ended is an ADT1-1WT. It limits the frequency response of the circuit so that measurements cannot be made below approximately 1 MHz.

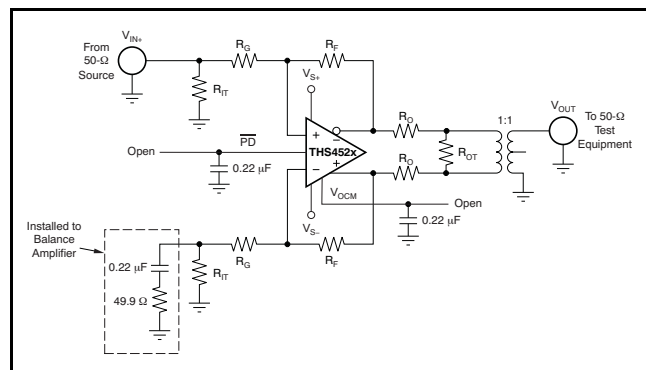


Figure 54. Distortion Test Circuit

Slew Rate, Transient Response, Settling Time, Output Impedance, Overdrive, Output Voltage, and Turn-On/Turn-Off Time

The circuit shown in [Figure 55](#) is used to measure slew rate, transient response, settling time, output impedance, overdrive recovery, output voltage swing, and amplifier turn-on/turn-off time. Turn-on and turn-off time are measured with the same circuit modified for 50- Ω input impedance on the \overline{PD} input by replacing the 0.22- μ F capacitor with a 49.9- Ω resistor. For output impedance, the signal is injected at V_{OUT} with V_{IN} open; the drop across the 2x 49.9- Ω resistors is then used to calculate the impedance seen looking into the amplifier output.

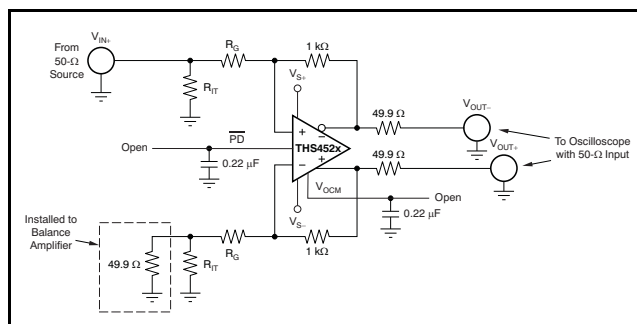


Figure 55. Slew Rate, Transient Response, Settling Time, Output Impedance, Overdrive Recovery, V_{OUT} Swing, and Turn-On/Turn-Off Test Circuit

Common-Mode and Power-Supply Rejection

The circuit shown in Figure 56 is used to measure the CMRR. The signal from the network analyzer is applied common-mode to the input. Figure 57 is used to measure the PSRR of V_{S+} and V_{S-} . The power supply under test is applied to the network analyzer dc offset input. For both CMRR and PSRR, the output is probed using a Tektronix high-impedance differential probe across the 953- Ω resistor and referred to the amplifier output by adding back the 0.42-dB as a result of the voltage divider on the output. For these tests, the resistors are matched for best results.

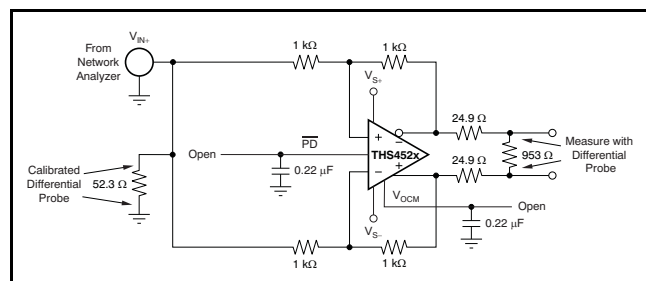


Figure 56. CMRR Test Circuit

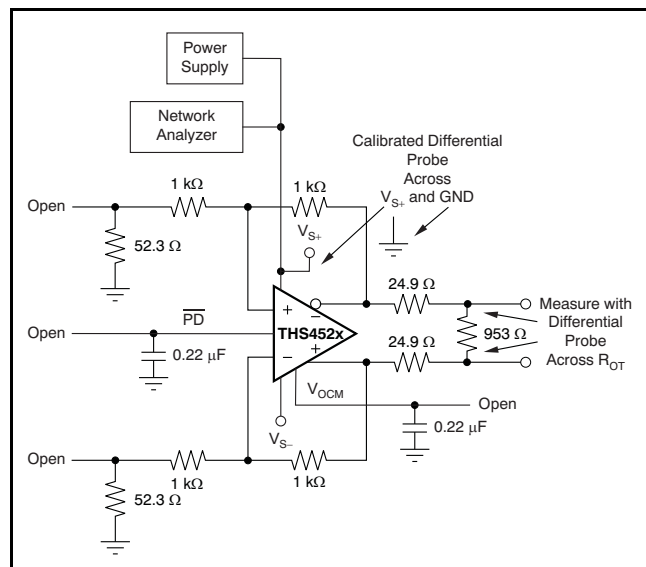


Figure 57. PSRR Test Circuit

V_{OCM} Input

The circuit illustrated in Figure 58 is used to measure the frequency response and input impedance of the V_{OCM} input. Frequency response is measured using a Tektronix high-impedance differential probe, with $R_{CM} = 0 \Omega$ at the common point of V_{OUT+} and V_{OUT-} , formed at the summing junction of the two matched 499- Ω resistors, with respect to ground. The input impedance is measured using a Tektronix high-impedance differential probe at the V_{OCM} input with $R_{CM} = 10 \text{ k}\Omega$ and the drop across the 10-k Ω resistor is used to calculate the impedance seen looking into the amplifier V_{OCM} input.

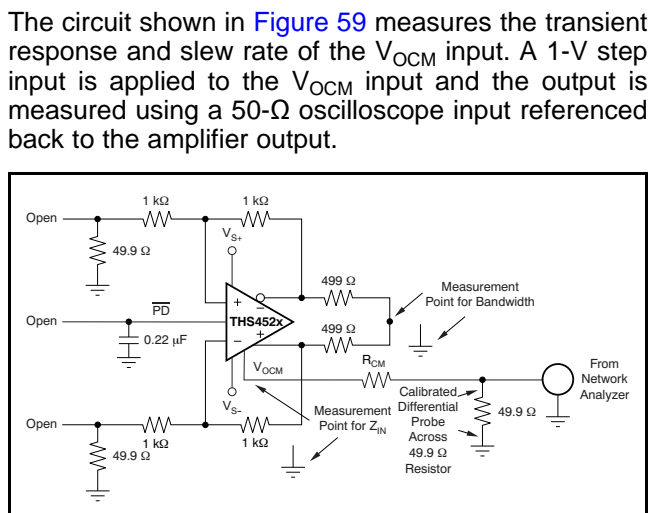


Figure 58. V_{OCM} Input Test Circuit

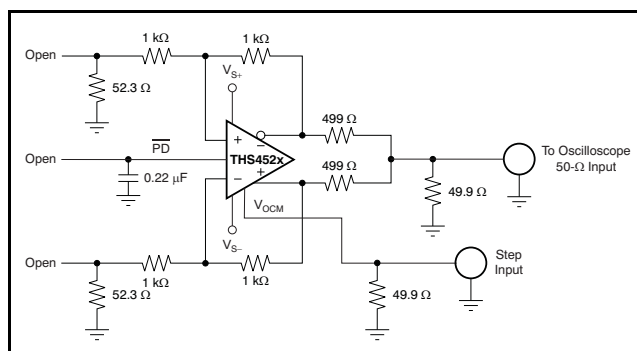


Figure 59. V_{OCM} Transient Response and Slew Rate Test Circuit

APPLICATION INFORMATION

The following circuits show application information for the THS4521, THS4522, and THS4524 family. For simplicity, power-supply decoupling capacitors are not shown in these diagrams; see the [EVM and Layout Recommendations](#) section for suggested guidelines. For more details on the use and operation of fully differential op amps, refer to the Application Report [Fully-Differential Amplifiers \(SLOA054\)](#), available for download from the TI web site at www.ti.com.

Differential Input to Differential Output Amplifier

The THS4521, THS4522, and THS4524 family are fully-differential operational amplifiers that can be used to amplify differential input signals to differential output signals. [Figure 60](#) shows a basic block diagram of the circuit (V_{OCM} and PD inputs not shown). The gain of the circuit is set by R_F divided by R_G .

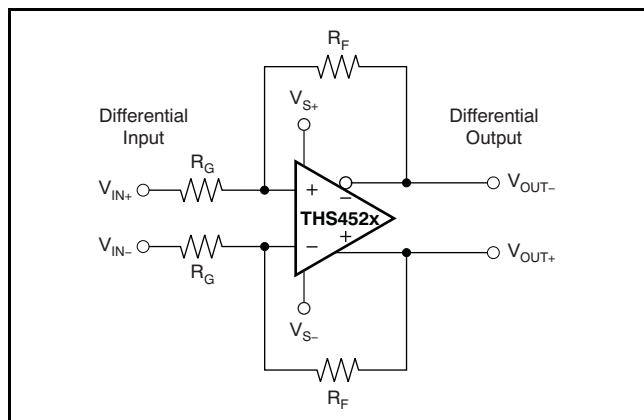


Figure 60. Differential Input to Differential Output Amplifier

Single-Ended Input to Differential Output Amplifier

The THS4521, THS4522, and THS4524 family can also amplify and convert single-ended input signals to differential output signals. [Figure 61](#) illustrates a basic block diagram of the circuit (V_{OCM} and PD inputs not shown). The gain of the circuit is again set by R_F divided by R_G .

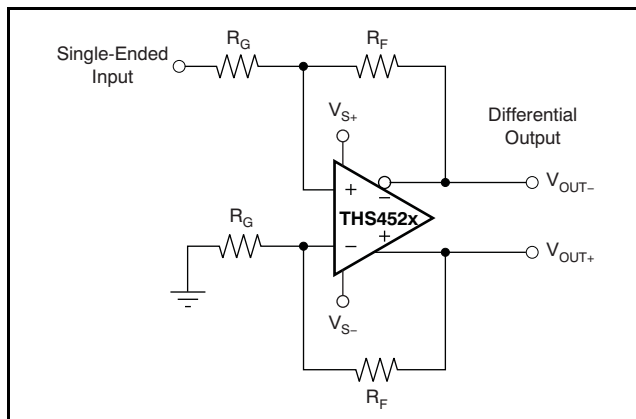


Figure 61. Single-Ended Input to Differential Output Amplifier

Input Common-Mode Voltage Range

The input common-mode voltage of a fully-differential op amp is the voltage at the + and – input pins of the device.

It is important to not violate the input common-mode voltage range (V_{ICR}) of the op amp. Assuming the op amp is in linear operation, the voltage across the input pins is only a few millivolts at most. Therefore, finding the voltage at one input pin determines the input common-mode voltage of the op amp.

Treating the negative input as a summing node, the voltage is given by [Equation 1](#):

$$\left(V_{OUT+} \times \frac{R_G}{R_G + R_F} \right) + \left(V_{IN-} \times \frac{R_F}{R_G + R_F} \right) \quad (1)$$

To determine the V_{ICR} of the op amp, the voltage at the negative input is evaluated at the extremes of V_{OUT+} . As the gain of the op amp increases, the input common-mode voltage becomes closer and closer to the input common-mode voltage of the source.

Setting the Output Common-Mode Voltage

The output common-mode voltage is set by the voltage at the V_{OCM} pin. The internal common-mode control circuit maintains the output common-mode voltage within 5-mV offset (typ) from the set voltage. If left unconnected, the common-mode set point is set to midsupply by internal circuitry, which may be overdriven from an external source. Figure 62 represents the V_{OCM} input. The internal V_{OCM} circuit has typically 23 MHz of –3 dB bandwidth, which is required for best performance, but it is intended to be a dc bias input pin. A 0.22-μF bypass capacitor is recommended on this pin to reduce noise. The external current required to overdrive the internal resistor divider is given approximately by the formula in Equation 2:

$$I_{EXT} = \frac{2V_{OCM} - (V_{S+} - V_{S-})}{50 \text{ k}\Omega} \quad (2)$$

where:

- V_{OCM} is the voltage applied to the V_{OCM} pin

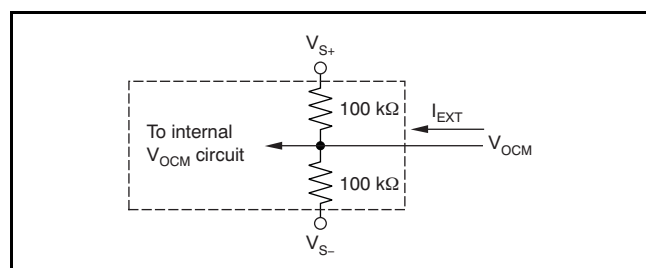


Figure 62. V_{OCM} Input Circuit

Single-Supply Operation (3 V to 5 V)

To facilitate testing with common lab equipment, the THS4521EVM allows for split-supply operation; most of the characterization data presented in this data sheet is measured using split-supply power inputs. The device can easily be used with a single-supply power input without degrading performance.

Figure 63 shows a dc-coupled single-supply circuit with single-ended inputs. This circuit can also be applied to differential input sources.

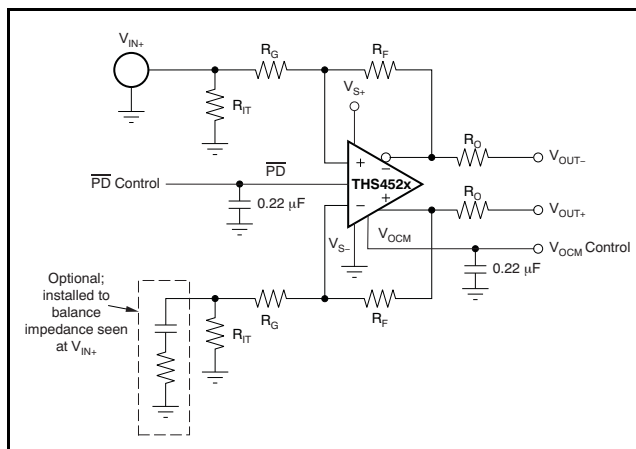


Figure 63. THS4521 DC-Coupled Single-Supply with Single-Ended Inputs

The input common-mode voltage range of the THS4521, THS4522, and THS4524 family is designed to include the negative supply voltage. In the circuit shown in Figure 63, the signal source is referenced to ground. V_{OCM} is set by an external control source or, if left unconnected, the internal circuit defaults to midsupply. Together with the input impedance of the amplifier circuit, R_{IT} provides input termination, which is also referenced to ground.

Note that R_{IT} and optional matching components are added to the alternate input to balance the impedance at signal input.

Low-Power Applications and the Effects of Resistor Values on Bandwidth

For low-power operation, it may be necessary to increase the gain setting resistors values to limit current consumption and not load the source. Using larger value resistors lowers the bandwidth of the THS4521, THS4522, and THS4524 family as a result of the interactions between the resistors, the device parasitic capacitance, and printed circuit board (PCB) parasitic capacitance. Figure 64 shows the small-signal frequency response with 1-kΩ, 10-kΩ, and 100-kΩ resistors for R_F , R_G , and R_L (impedance is assumed to typically increase for all three resistors in low-power applications).

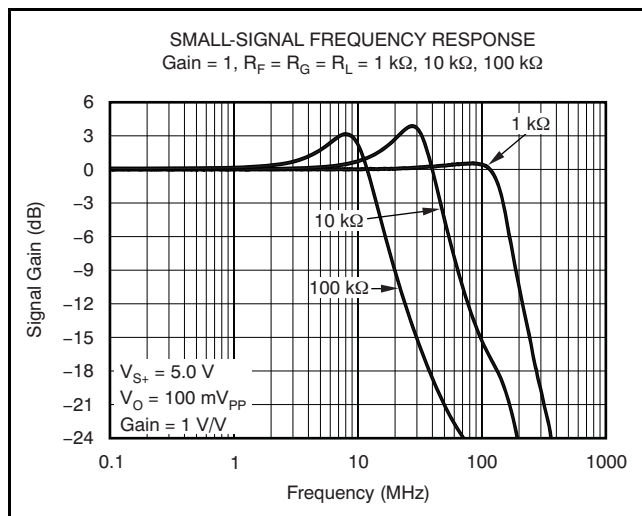


Figure 64. THS4521 Frequency Response with Various Gain Setting and Load Resistor Values

Frequency Response Variation due to Package Options

Users can see variations in the small-signal ($V_{OUT} = 100 \text{ mV}_{PP}$) frequency response between the available package options for the THS4521, THS4522, and THS4524 family as a result of parasitic elements associated with each package and board layout changes. Figure 65 shows the variance measured in the lab; this variance is to be expected even when using a good layout.

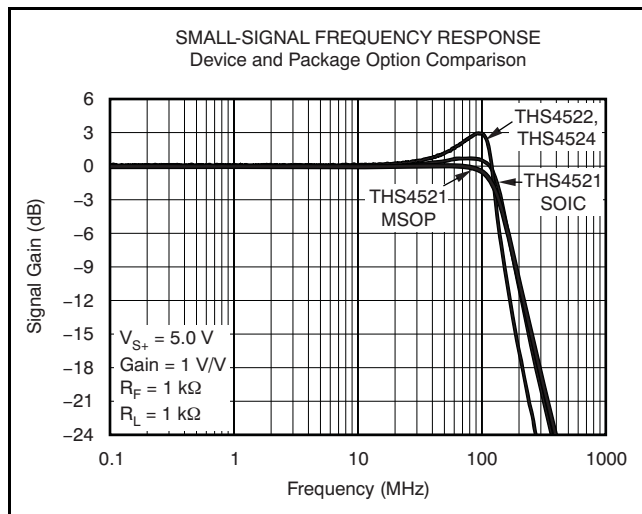


Figure 65. Small-Signal Frequency Response: Package Variations

Driving Capacitive Loads

The THS4521, THS4522, and THS4524 family is designed for a nominal capacitive load of 1 pF on each output to ground. When driving capacitive loads

greater than 1 pF, it is recommended to use small resistors (R_O) in series with the output, placed as close to the device as possible. Without R_O , capacitance on the output interacts with the output impedance of the amplifier and causes phase shift in the loop gain of the amplifier that reduces the phase margin. This reduction in phase margin results in frequency response peaking; overshoot, undershoot, and/or ringing when a step or square-wave signal is applied; and may lead to instability or oscillation. Inserting R_O isolates the phase shift from the loop gain path and restores the phase margin, but it also limits bandwidth. Figure 66 shows the recommended values of R_O versus capacitive loads (C_L). Figure 67 shows the frequency response with various values.

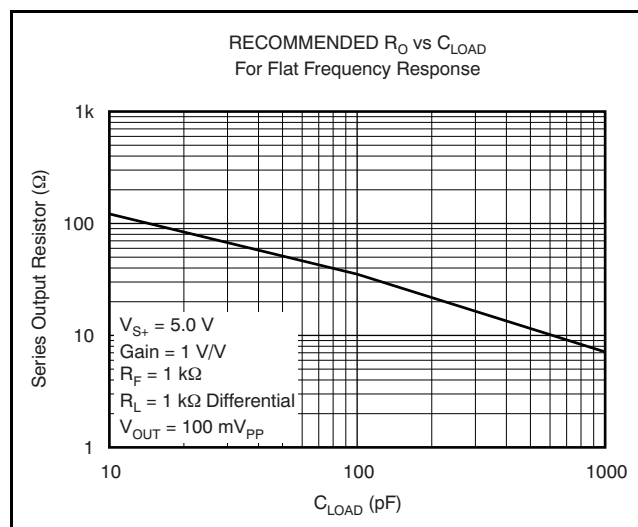


Figure 66. Recommended Series Output Resistor versus Capacitive Load for Flat Frequency Response, with $R_{LOAD} = 1 \text{ k}\Omega$

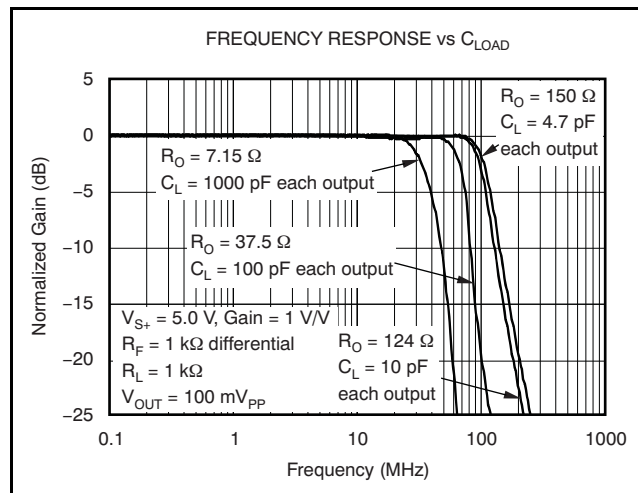


Figure 67. Frequency Response for Various R_O and C_L Values, with $R_{LOAD} = 1 \text{ k}\Omega$

Audio Performance

The THS4521, THS4522, and THS4524 family provide excellent audio performance with very low quiescent power. To show performance in the audio band, the device was tested with a SYS-2722 audio analyzer from Audio Precision. THD+N and FFT tests were performed at 1-V_{RMS} output voltage. Performance is the same on both 3.3-V and 5-V supplies. Figure 68 shows the test circuit used; Figure 69 and Figure 70 show the performance of the analyzer using internal loopback mode (generator) together with the THS4521. Note that the harmonic distortion performance is very close to the same with and without the device meaning the THS4521 performance is actually much better than can be directly measured by this method. Using these measurements and simulation, we estimate the second-order harmonic distortion to be -133 dBc and the third-order harmonic distortion to be -140 dBc at 10 kHz .

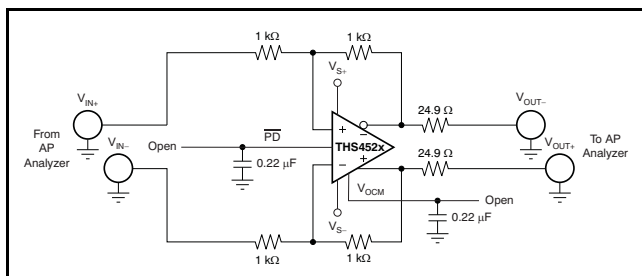


Figure 68. THS4521 AP Analyzer Test Circuit

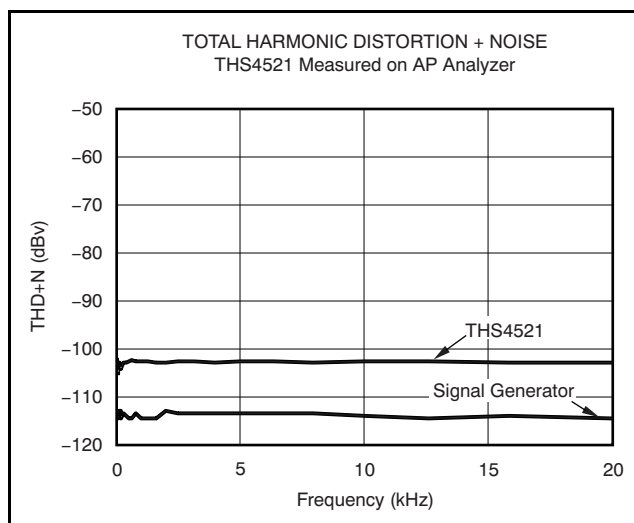


Figure 69. THS4521 1-V_{RMS} 20-Hz to 20-kHz THD+N

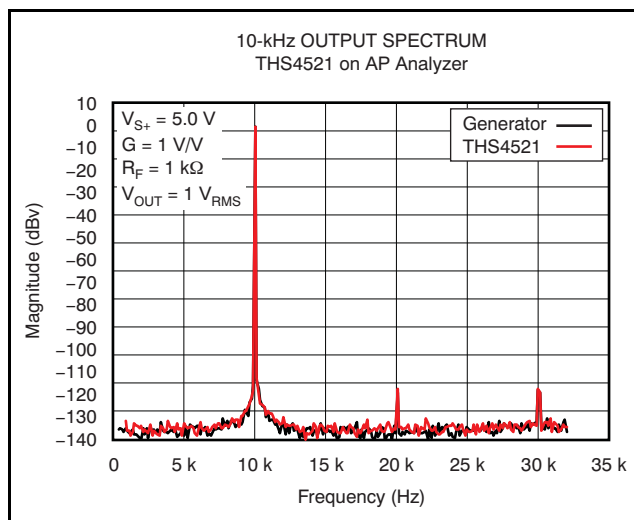


Figure 70. THS4521 1-V_{RMS} 10-kHz FFT Plot

ADC Driver Performance: THS4521 and ADS1278 Combined Performance

The THS4521 provides excellent performance when driving high-performance delta-sigma ($\Delta\Sigma$) and successive approximation register (SAR) ADCs in audio and industrial applications using a single 3-V to 5-V power supply. To show achievable performance, the THS4521 is tested as the drive amplifier for the [ADS1278](#) 24-bit ADC. The ADS1278 offers excellent ac and dc performance, with four selectable operating modes from 10 kSPS to 128 kSPS to enable the user to fine-tune performance and power for specific application needs. The circuit shown in [Figure 71](#) was used to test the performance. Data were taken using the High-Resolution mode (52 kSPS) of the ADS1278 with input frequencies at 1 kHz and 10 kHz and signal levels 1/2 dB below full-scale (–0.5 dBFS). FFT plots showing the spectral performance are given in [Figure 72](#) and [Figure 73](#); tabulated ac analysis results are shown in [Table 3](#).

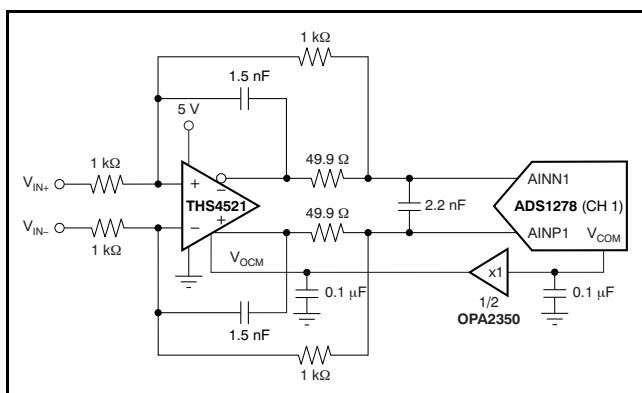


Figure 71. THS4521 and ADS1278 (Ch 1) Test Circuit

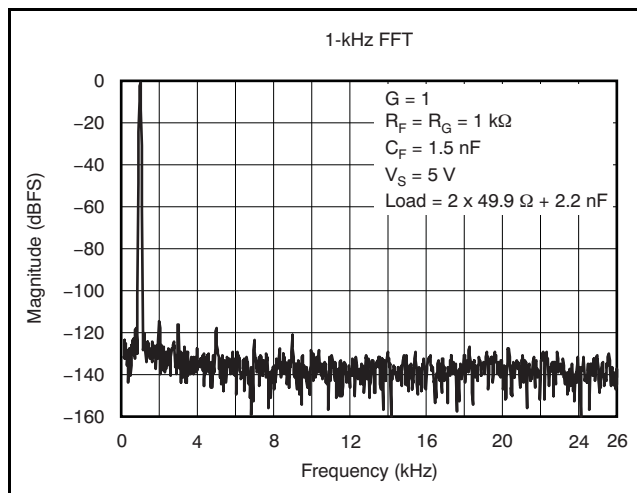


Figure 72. 1-kHz FFT

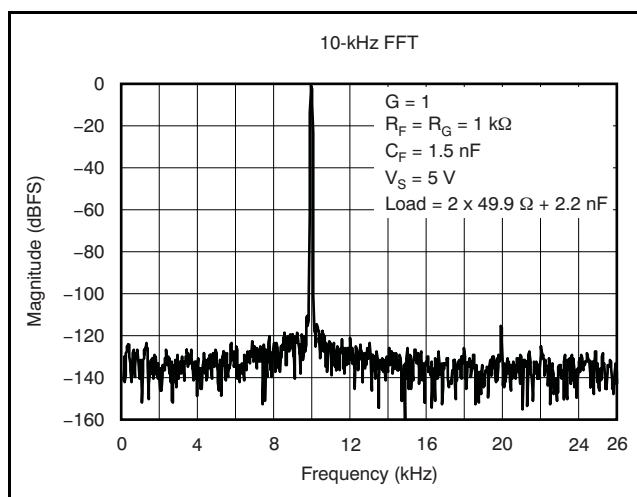


Figure 73. 10-kHz FFT

Table 3. AC Analysis

| Tone (Hz) | Signal (dBFS) | SNR (dBc) | THD (dBc) | SINAD (dBc) | SFDR (dBc) |
|-----------|---------------|-----------|-----------|-------------|------------|
| 1 k | –0.50 | 109.1 | –107.9 | 105.5 | 113.7 |
| 10 k | –0.50 | 101.8 | –109.8 | 101.1 | 109.8 |

ADC Driver Performance: THS4521 and ADS8321 Combined Performance

To demonstrate achievable performance, the THS4521 is tested as the drive amplifier for the ADS8321 16-bit SAR ADC. The ADS8321 offers excellent ac and dc performance, with ultra-low power and small size. The circuit shown in Figure 74 was used to test the performance. Data were taken using the ADS8321 at 100 kSPS with input frequencies of 2 kHz and 10 kHz and signal levels that were -0.5 dBFS. FFT plots that illustrate the spectral performance are given in Figure 75 and Figure 76. Tabulated ac analysis results are listed in Table 4.

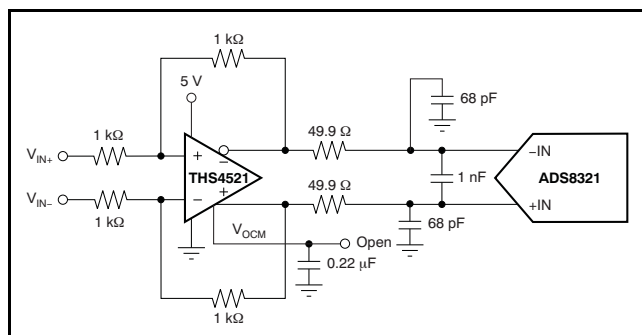


Figure 74. THS4521 and ADS8321 Test Circuit

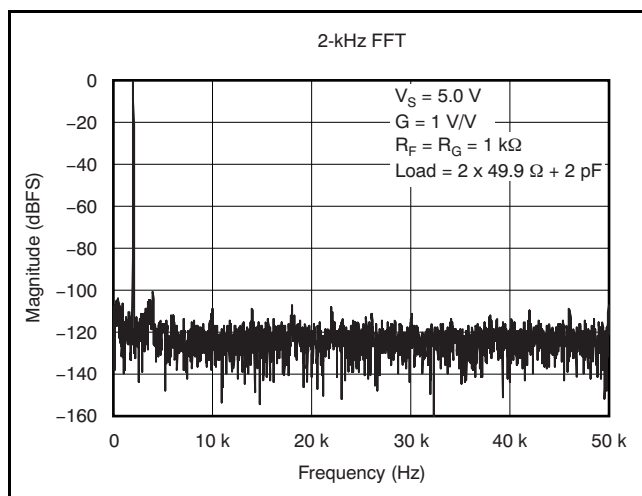


Figure 75. 2-kHz FFT

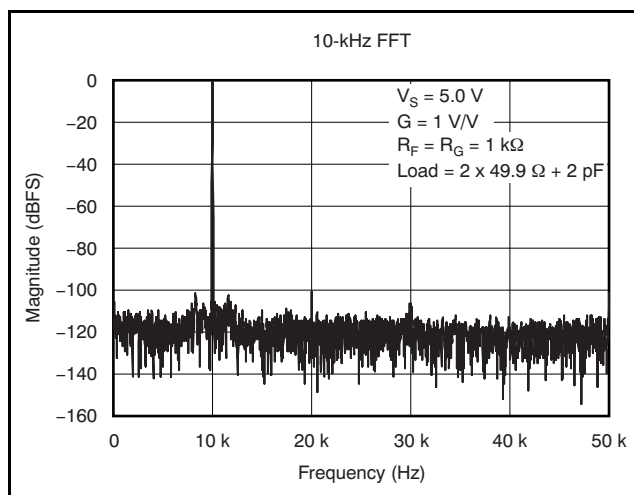


Figure 76. 10-kHz FFT

Table 4. AC Analysis

| Tone (Hz) | Signal (dBFS) | SNR (dBc) | THD (dBc) | SINAD (dBc) | SFDR (dBc) |
|-----------|---------------|-----------|-----------|-------------|------------|
| 2 k | -0.5 | 86.7 | -97.8 | 86.4 | 100.7 |
| 10 k | -0.6 | 85.2 | -98.1 | 85.2 | 102.2 |

EVM AND LAYOUT RECOMMENDATIONS

Figure 77 shows the THS4521EVM schematic. PCB layers 1 through 4 are shown in Figure 78; Table 5 lists the bill of materials for the THS4521EVM as supplied from TI. It is recommended to follow the layout of the external components near to the amplifier, ground plane construction, and power routing as closely as possible. Follow these general guidelines:

1. Signal routing should be direct and as short as possible into and out of the op amp circuit.
2. The feedback path should be short and direct.
3. Ground or power planes should be removed from directly under the amplifier input and output pins.
4. An output resistor is recommended in each output lead, placed as near to the output pins as possible.
5. Two 0.1- μ F power-supply decoupling capacitors should be placed as near to the power-supply pins as possible.
6. Two 10- μ F power-supply decoupling capacitors should be placed within 1 inch of the device and can be shared among multiple analog devices.
7. A 0.22- μ F capacitor should be placed between the V_{OCM} input pin and ground near to the pin. This capacitor limits noise coupled into the pin.
8. The \overline{PD} pin uses TTL logic levels; a bypass capacitor is not necessary if actively driven, but can be used for robustness in noisy environments whether driven or not.
9. If input termination resistors R_{10} and R_{11} are used, a single point connection to ground on L2 is recommended.

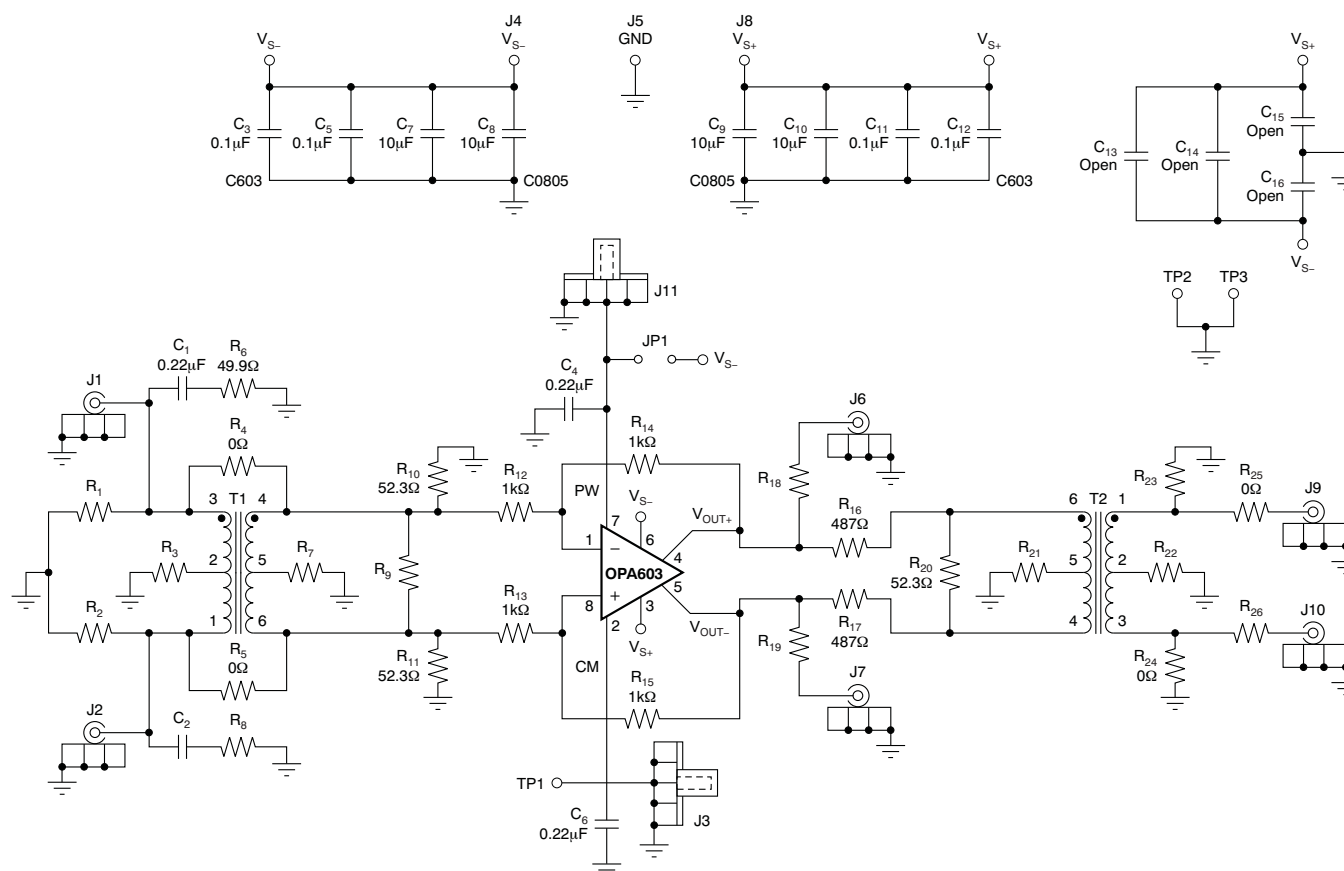


Figure 77. THS4521EVM: Schematic

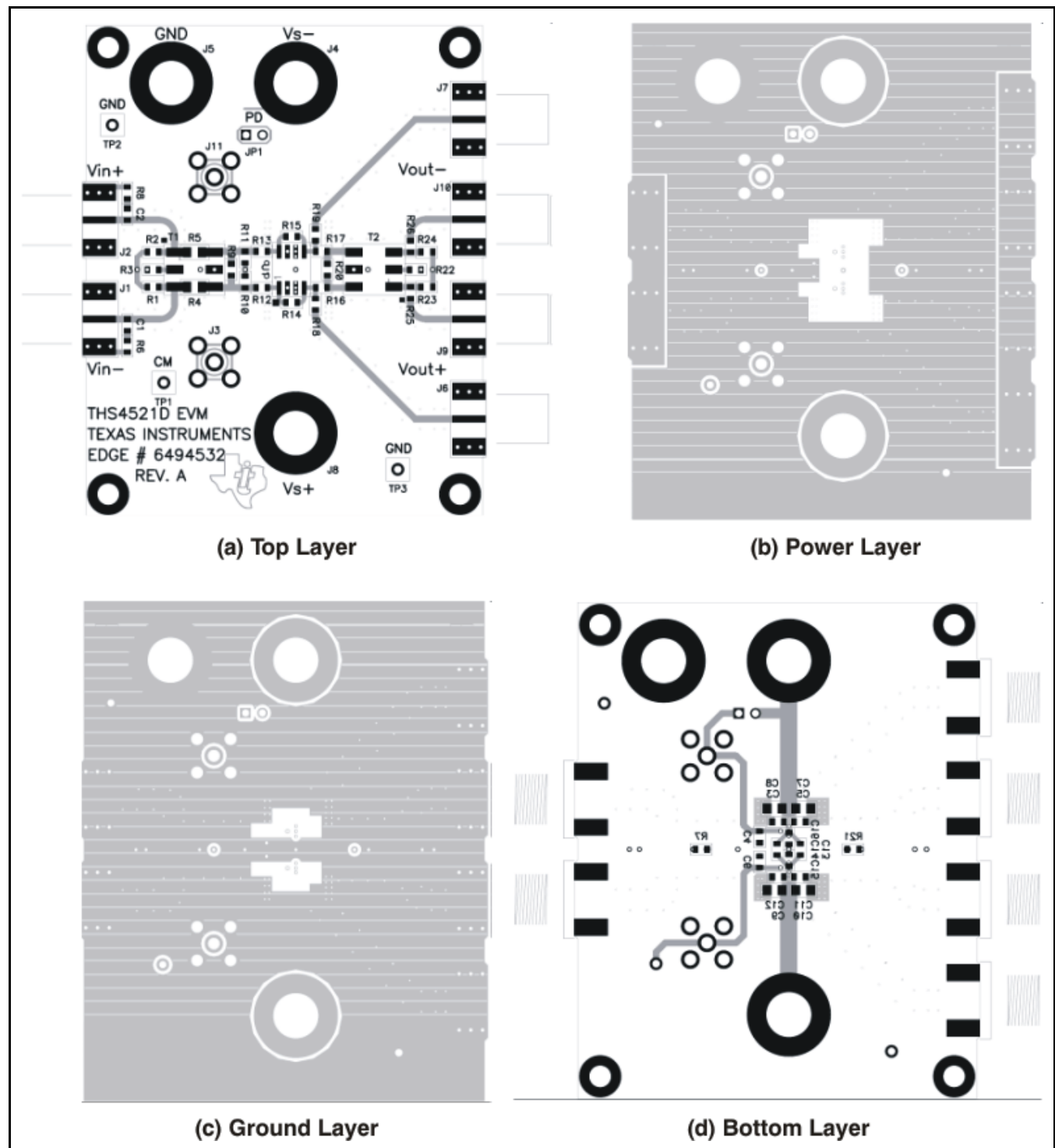


Figure 78. THS4521EVM: Layer 1 to Layer 4 Images

Table 5. THS4521EVM Parts List

| ITEM | DESCRIPTION | SMD SIZE | REFERENCE DESIGNATOR | QTY | MANUFACTURER PART NUMBER |
|------|--|----------|--|-----|--------------------------|
| 1 | Capacitor, 10.0 μ F, ceramic, X5R, 6.3 V | 0805 | C7, C8, C9, C10 | 4 | (AVX) 08056D106KAT2A |
| 2 | Capacitor, 0.1 μ F, ceramic, X7R, 16 V | 0603 | C3, C5, C11, C12 | 4 | (AVX) 0603YC104KAT2A |
| 3 | Capacitor, 0.22 μ F, ceramic, X7R, 10 V | 0603 | C1, C4, C6 | 3 | (AVX) 0603ZC224KAT2A |
| 4 | Open | 0603 | C2, C13, C14, C15, C16 | 5 | |
| 5 | Open | 0603 | R1, R2, R3, R7, R8, R9, R18, R19, R21, R22, R23, R26 | 12 | |
| 6 | Resistor, 0 Ω | 0603 | R24, R25 | 2 | (ROHM) MCR03EZPJ000 |
| 7 | Resistor, 49.9 Ω , 1/10W, 1% | 0603 | R6 | 1 | (ROHM) MCR03EZPFX49R9 |
| 8 | Resistor, 52.3 Ω , 1/10W, 1% | 0603 | R10, R11, R20 | 3 | (ROHM) MCR03EZPFX52R3 |
| 9 | Resistor, 487 Ω , 1/10W, 1% | 0603 | R16, R17 | 2 | (ROHM) MCR03EZPFX4870 |
| 10 | Resistor, 1k Ω , 1/10W, 1% | 0603 | R12, R13, R14, R15 | 4 | (ROHM) MCR03EZPFX1001 |
| 11 | Resistor, 0 Ω | 0805 | R4, R5 | 2 | (ROHM) MCR10EZPJ000 |
| 12 | Open | | T1 | 1 | |
| 13 | Transformer, RF | | T2 | 1 | (MINI-CIRCUITS) ADT1-1WT |
| 14 | Jack, Banana receptance, 0.25-in dia. hole | | J4, J5, J8 | 3 | (SPC) 813 |
| 15 | Open | | J1, J3, J6, J7, J10, J11 | 6 | |
| 16 | Connector, edge, SMA PCB jack | | J2, J9 | 2 | (JOHNSON) 142-0701-801 |
| 17 | Header, 0.1 in CTRS, 0.025-in sq. pins | 2 POS. | JP1 | 1 | (SULLINS) PBC36SAAN |
| 18 | Shunts | | JP1 | 1 | (SULLINS) SSC02SYAN |
| 19 | Test point, Red | | TP1 | 1 | (KEYSTONE) 5000 |
| 20 | Test point, Black | | TP2, TP3 | 2 | (KEYSTONE) 5001 |
| 21 | IC, THS4521 | | U1 | 1 | (TI) THS4521D |
| 22 | Standoff, 4-40 hex, 0.625 in length | | | 4 | (KEYSTONE) 1808 |
| 23 | Screw, Phillips, 4-40, .250 in | | | 4 | SHR-0440-016-SN |
| 24 | Board, printed circuit | | | 1 | (TI) EDGE# 6494532 |

EVALUATION BOARD/KIT IMPORTANT NOTICE

Texas Instruments (TI) provides the enclosed product(s) under the following conditions:

This evaluation board/kit is intended for use for **ENGINEERING DEVELOPMENT, DEMONSTRATION, OR EVALUATION PURPOSES ONLY** and is not considered by TI to be a finished end-product fit for general consumer use. Persons handling the product(s) must have electronics training and observe good engineering practice standards. As such, the goods being provided are not intended to be complete in terms of required design-, marketing-, and/or manufacturing-related protective considerations, including product safety and environmental measures typically found in end products that incorporate such semiconductor components or circuit boards. This evaluation board/kit does not fall within the scope of the European Union directives regarding electromagnetic compatibility, restricted substances (RoHS), recycling (WEEE), FCC, CE or UL, and therefore may not meet the technical requirements of these directives or other related directives.

Should this evaluation board/kit not meet the specifications indicated in the User's Guide, the board/kit may be returned within 30 days from the date of delivery for a full refund. THE FOREGOING WARRANTY IS THE EXCLUSIVE WARRANTY MADE BY SELLER TO BUYER AND IS IN LIEU OF ALL OTHER WARRANTIES, EXPRESSED, IMPLIED, OR STATUTORY, INCLUDING ANY WARRANTY OF MERCHANTABILITY OR FITNESS FOR ANY PARTICULAR PURPOSE.

The user assumes all responsibility and liability for proper and safe handling of the goods. Further, the user indemnifies TI from all claims arising from the handling or use of the goods. Due to the open construction of the product, it is the user's responsibility to take any and all appropriate precautions with regard to electrostatic discharge.

EXCEPT TO THE EXTENT OF THE INDEMNITY SET FORTH ABOVE, NEITHER PARTY SHALL BE LIABLE TO THE OTHER FOR ANY INDIRECT, SPECIAL, INCIDENTAL, OR CONSEQUENTIAL DAMAGES.

TI currently deals with a variety of customers for products, and therefore our arrangement with the user **is not exclusive**.

TI assumes **no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein**.

Please read the User's Guide and, specifically, the Warnings and Restrictions notice in the User's Guide prior to handling the product. This notice contains important safety information about temperatures and voltages. For additional information on TI's environmental and/or safety programs, please contact the TI application engineer or visit www.ti.com/esh.

No license is granted under any patent right or other intellectual property right of TI covering or relating to any machine, process, or combination in which such TI products or services might be or are used.

FCC Warning

This evaluation board/kit is intended for use for **ENGINEERING DEVELOPMENT, DEMONSTRATION, OR EVALUATION PURPOSES ONLY** and is not considered by TI to be a finished end-product fit for general consumer use. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to part 15 of FCC rules, which are designed to provide reasonable protection against radio frequency interference. Operation of this equipment in other environments may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range of 3 V to 5.5 V and the output voltage range of 3 V to 5.5 V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than +85°C. The EVM is designed to operate properly with certain components above +85°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2008, Texas Instruments Incorporated

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| THS4521ID | ACTIVE | SOIC | D | 8 | 75 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| THS4521IDGKR | ACTIVE | MSOP | DGK | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| THS4521IDGKT | ACTIVE | MSOP | DGK | 8 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| THS4521IDR | ACTIVE | SOIC | D | 8 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1 YEAR |
| THS4522IPW | ACTIVE | TSSOP | PW | 16 | 90 | Green (RoHS & no Sb/Br) | Cu NiPdAu | Level-2-260C-1 YEAR |
| THS4522IPWR | ACTIVE | TSSOP | PW | 16 | 2000 | Green (RoHS & no Sb/Br) | Cu NiPdAu | Level-2-260C-1 YEAR |
| THS4524IDBT | PREVIEW | TSSOP | DBT | 38 | 50 | TBD | Call TI | Call TI |
| THS4524IDBTR | PREVIEW | TSSOP | DBT | 38 | 2000 | TBD | Call TI | Call TI |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

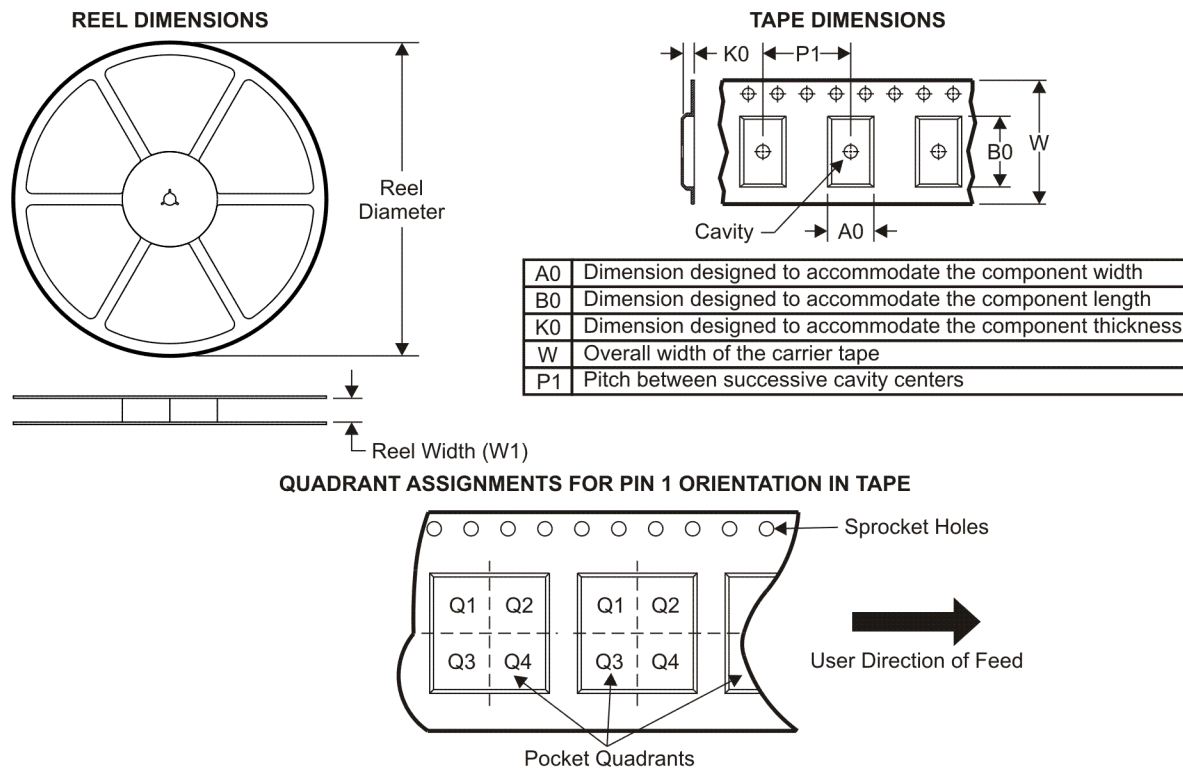
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

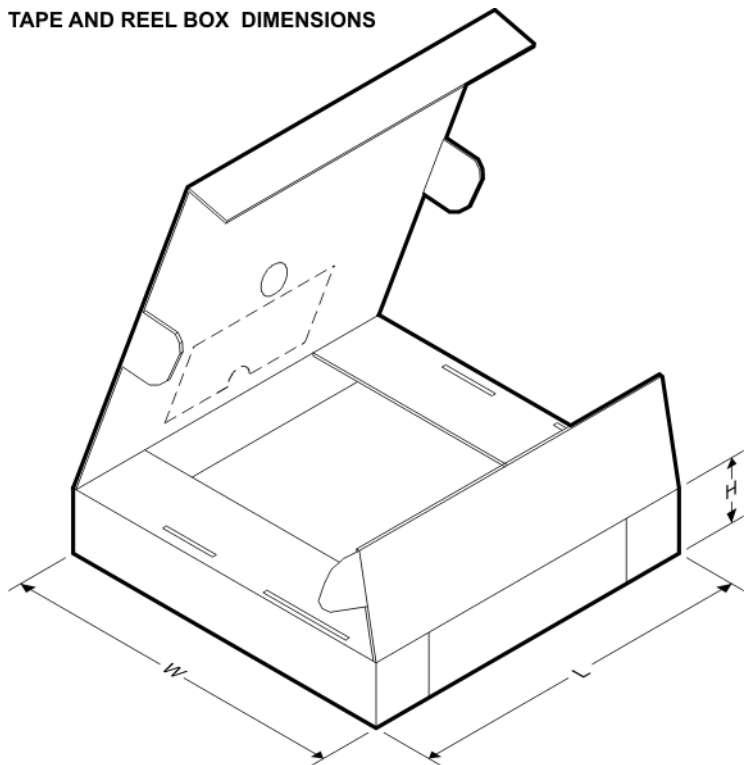
TAPE AND REEL INFORMATION



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| THS4521IDGKR | MSOP | DGK | 8 | 2500 | 330.0 | 12.4 | 5.3 | 3.4 | 1.4 | 8.0 | 12.0 | Q1 |
| THS4521IDGKT | MSOP | DGK | 8 | 250 | 180.0 | 12.4 | 5.3 | 3.4 | 1.4 | 8.0 | 12.0 | Q1 |
| THS4521IDR | SOIC | D | 8 | 2500 | 330.0 | 12.4 | 6.4 | 5.2 | 2.1 | 8.0 | 12.0 | Q1 |
| THS4522IPWR | TSSOP | PW | 16 | 2000 | 330.0 | 12.4 | 7.0 | 5.6 | 1.6 | 8.0 | 12.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS



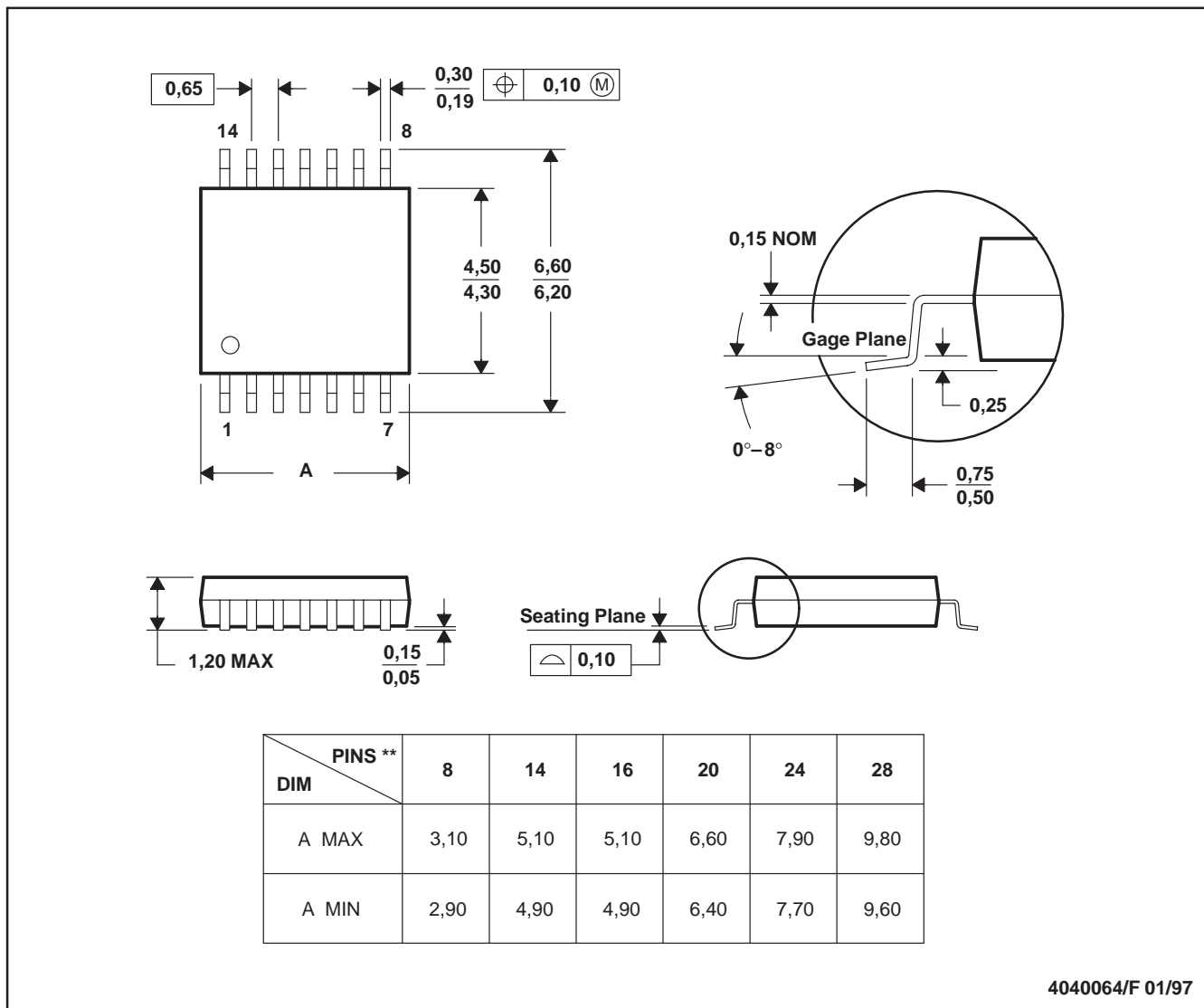
*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| THS4521IDGKR | MSOP | DGK | 8 | 2500 | 346.0 | 346.0 | 29.0 |
| THS4521IDGKT | MSOP | DGK | 8 | 250 | 190.5 | 212.7 | 31.8 |
| THS4521IDR | SOIC | D | 8 | 2500 | 346.0 | 346.0 | 29.0 |
| THS4522IPWR | TSSOP | PW | 16 | 2000 | 346.0 | 346.0 | 29.0 |

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

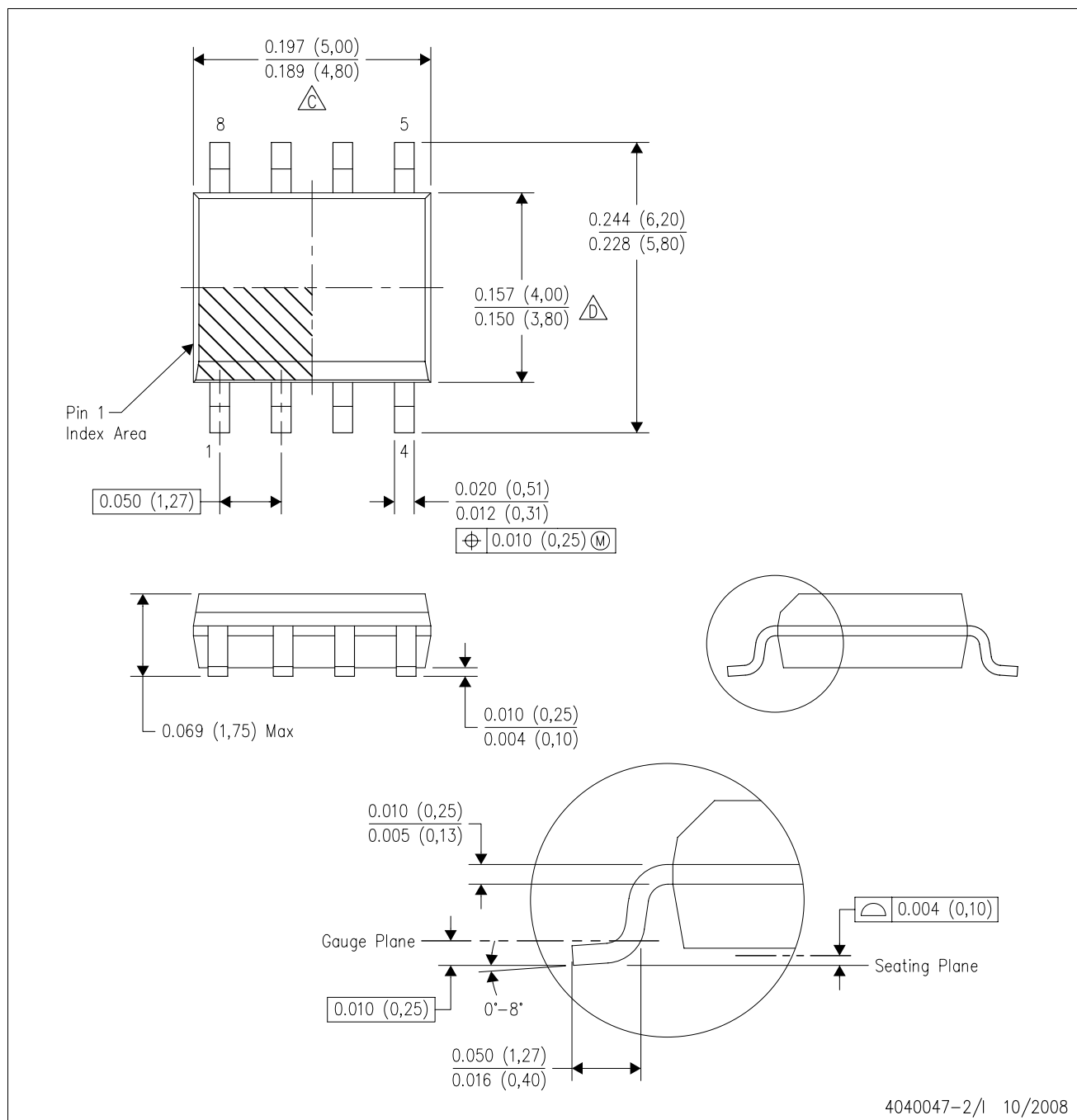
14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

D (R-PDSO-G8)

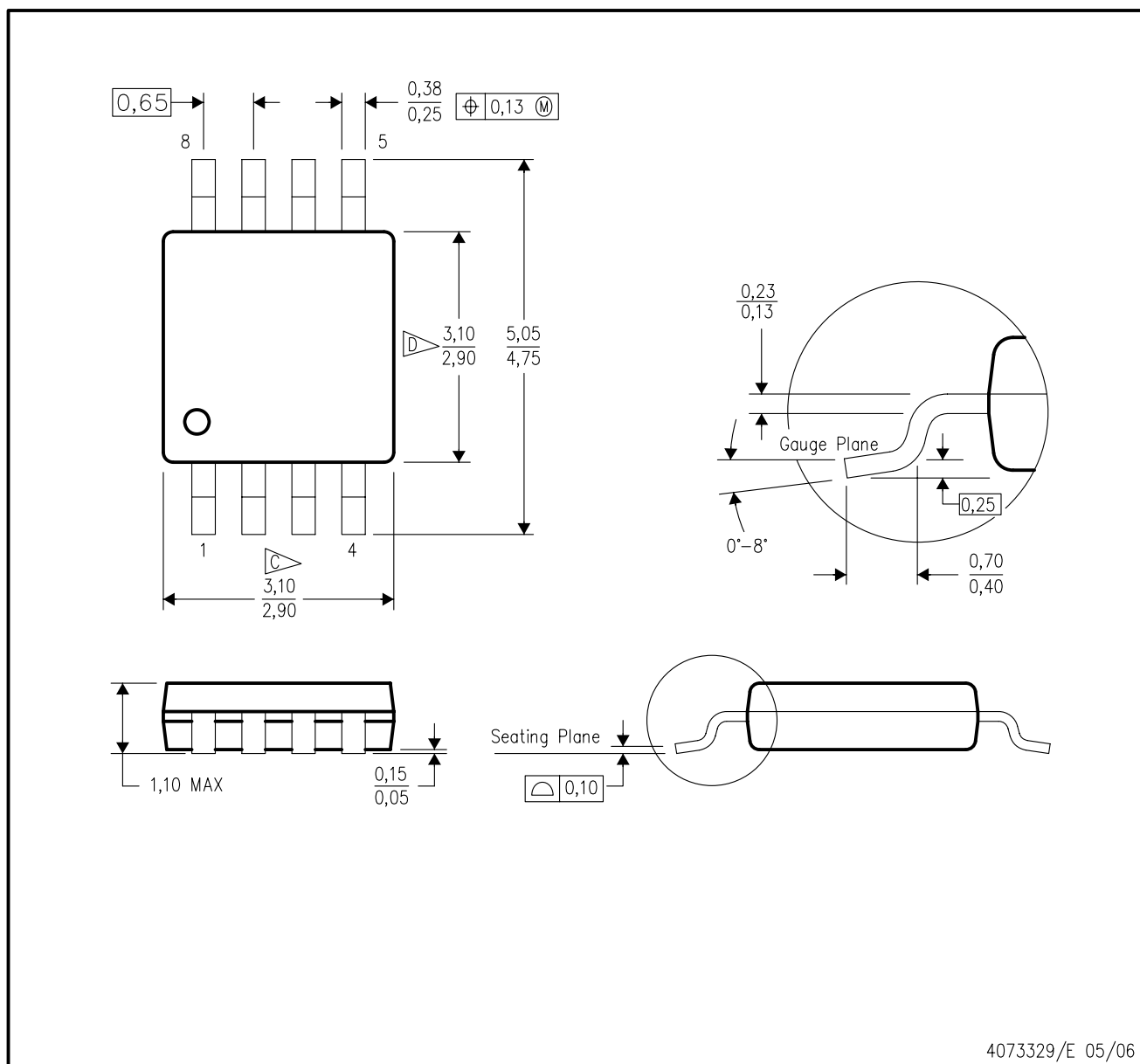
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.
 - E. Reference JEDEC MS-012 variation AA.

DGK (S-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
- E. Falls within JEDEC MO-187 variation AA, except interlead flash.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products

| | |
|-----------------------------|--|
| Amplifiers | amplifier.ti.com |
| Data Converters | dataconverter.ti.com |
| DLP® Products | www.dlp.com |
| DSP | dsp.ti.com |
| Clocks and Timers | www.ti.com/clocks |
| Interface | interface.ti.com |
| Logic | logic.ti.com |
| Power Mgmt | power.ti.com |
| Microcontrollers | microcontroller.ti.com |
| RFID | www.ti-rfid.com |
| RF/IF and ZigBee® Solutions | www.ti.com/lprf |

Applications

| | |
|--------------------|--|
| Audio | www.ti.com/audio |
| Automotive | www.ti.com/automotive |
| Broadband | www.ti.com/broadband |
| Digital Control | www.ti.com/digitalcontrol |
| Medical | www.ti.com/medical |
| Military | www.ti.com/military |
| Optical Networking | www.ti.com/opticalnetwork |
| Security | www.ti.com/security |
| Telephony | www.ti.com/telephony |
| Video & Imaging | www.ti.com/video |
| Wireless | www.ti.com/wireless |

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2009, Texas Instruments Incorporated